

TPS92200 具有灵活调光选项的 4V 至 30V 输入电压、1.5A 输出电流、同步降压 LED 驱动器

1 特性

- 4V 至 30V 宽输入范围
- 集成 150mΩ 和 90mΩ MOSFET，持续输出电流为 1.5A
- 超低关断电流：1 μA
- 从负载汲取的超低输出放电电流：1 μA
- 1MHz 开关频率
- 超大占空比高达 99%
- 峰值电流模式，具有内部补偿
- 灵活的调光选项：
 - TPS92200D1：具有数字输入的 PWM 调光和具有模拟输入的模拟调光
 - TPS92200D2：具有数字输入的模拟调光
- 超低而准确的 FB 电压：99mV ±3mV
- 全面保护特性：
 - LED 开路负载保护
 - LED+ 接地短路保护，具有自动重试功能
 - LED+ 和 LED 短路保护，具有自动重试功能
 - 传感电阻器开路负载和接地短路保护，具有自动重试功能
 - 具有自动重试功能的热关断保护
- SOT23 (6) 封装
- VQFN-HR (6) 封装

2 应用

- 视频监控 IR/白光 LED 驱动器
- 面部识别 IR LED 驱动器
- 舞台照明 LED 驱动器
- 一般工业和商业用照明
- 医疗 UV LED 驱动器
- AA 或锂离子电池充电器

3 说明

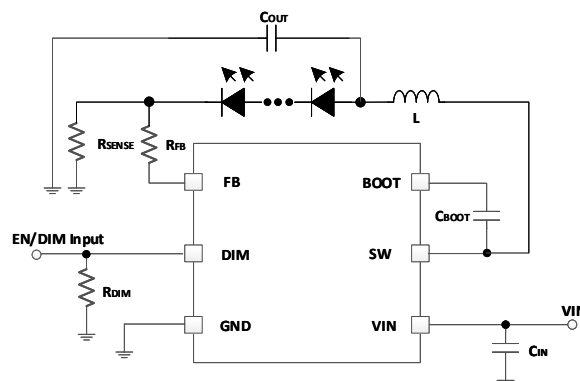
TPS92200 器件是一款具有 30V 最大输入电压的 1.5A 同步降压 LED 驱动器。通过集成高侧和低侧 NMOS 开关，TPS92200 器件以超小的解决方案尺寸提供高功率密度和高效率。TPS92200 器件使用峰值电流模式控制和全面内部补偿在各种运行条件下提供高瞬态响应性能。

TPS92200 器件支持灵活的调光方法。TPS92200D1 可实施 PWM 调光模式和模拟调光模式。在 PWM 调光模式下，LED 根据 PWM 占空比周期性地打开和关闭。该器件通过改变与 5% 至 100% 范围内的模拟输入电压电平成比例的内部基准电压来实现模拟调光模式。TPS92200D2 通过改变与 1% 至 100% 范围内的 PWM 信号输入占空比成比例的内部基准电压来实现更深层模拟调光。

在安全和保护方面，TPS92200 器件可实现全面保护，包括 LED 开路、LED+ 接地短路、LED 短路、检测电阻开路 and 短路以及器件热保护。

器件信息

器件型号	封装	封装尺寸 (标称值)
TPS92200D1DDCR	SOT-23-THIN (6)	1.60mm × 2.90mm
TPS92200D2DDCR	SOT-23-THIN (6)	1.60mm × 2.90mm
TPS92200D1RXLR	VQFN-HR (6)	1.50mm × 2.00mm
TPS92200D2RXLR	VQFN-HR (6)	1.50mm × 2.00mm



简化版原理图



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4 Revision History

注：以前版本的页码可能与当前版本的页码不同

Changes from Revision A (September 2021) to Revision B (January 2022)	Page
• 删除了 VQFN-HR 封装预发布说明.....	1
• Updated <i>ESD Ratings</i> table with correct description for CDM testing.....	4

Changes from Revision * (May 2020) to Revision A (September 2021)	Page
• 更新了整个文档中的表格、图和交叉参考的编号格式.....	1
• 添加了 VQFN-HR 封装信息.....	1
• 添加了 VQFN-HR 封装信息.....	1
• Add VQFN-HR package information.....	3
• Added VQFN-HR package information.....	30

5 Pin Configuration and Functions

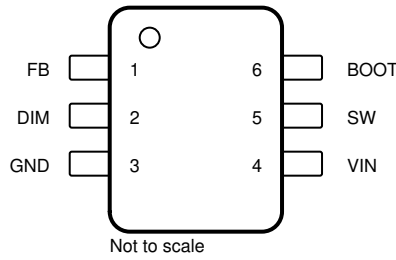


图 5-1. DDC Package 6-Pin SOT-23-THIN Top View

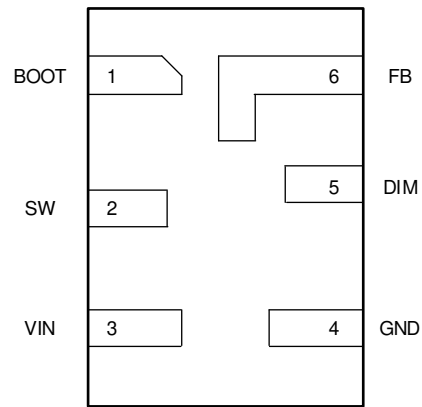


图 5-2. RXL Package 6-Pin VQFN-HR Top View

表 5-1. Pin Functions

PIN			TYPE ⁽¹⁾	DESCRIPTION
NAME	DDC NO.	RXL NO.		
BOOT	6	1	O	A bootstrap capacitor is required between BOOT and SW.
FB	1	6	I	LED current detection feedback
GND	3	4	G	Power ground
DIM	2	5	I	Dimming input. In PWM dimming mode, LED current is turned ON and OFF according to PWM duty cycle periodically (TPS92200D1). In analog dimming mode, the internal reference is proportional to the analog voltage on DIM pin (TPS92200D1) or the PWM duty input (TPS92200D2).
SW	5	2	O	Switching node to external inductor
VIN	4	3	P	Input supply voltage

(1) I = Input, O = Output, P = Supply, G = Ground

6 Specifications

6.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
Input voltage range, V_I	IN	- 0.3	32	V
	DIM	- 0.3	7	V
	FB	- 0.3	7	V
Output voltage range, V_O	BOOT-SW	- 0.3	7	V
	SW	- 0.3	32	V
	SW (20 ns transient)	- 5	32	V
Operating junction temperature, T_J		- 40	150	°C
Storage temperature range, T_{stg}		- 65	150	°C

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	±500	

- (1) JEDEC document JEP155 states that 500-V HBM allows safemanufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safemanufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

		MIN	MAX	UNIT
Input voltage range	IN	4	30	V
	DIM	- 0.1	6	V
	FB	- 0.1	6	V
Output voltage range	BOOT-SW	- 0.1	6	V
	SW	- 0.1	30	V
Operating Junction temperature, T_J		- 40	125	°C

6.4 Thermal Information

THERMAL METRIC ⁽¹⁾		TPS92200	TPS92200	UNIT
		DDC (SOT23-6)	RXL (VQFN-HR-6)	
		6 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	123.4	136.1	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	60.5	95.3	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	41.4	49.3	°C/W
ψ_{JT}	Junction-to-top characterization parameter	12.3	4.6	°C/W
ψ_{JB}	Junction-to-board characterization parameter	40.9	48.1	°C/W

- (1) For more information about traditional and new thermalmetrics, see the *Semiconductor and IC Package Thermal Metrics* application report, [SPRA953](#).

6.5 Electrical Characteristics

The electrical ratings specified in this section apply to all specifications in this document, unless otherwise noted. These specifications are interpreted as conditions that do not degrade the device parametric or functional specifications for the life of the product containing it. $T_J = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, $V_{IN} = 4\text{ V}$ to 30 V , (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
INPUT SUPPLY						
V_{IN}	Input voltage range		4		30	V
V_{IN_UVLO}	V_{IN} undervoltage lockout	Rising V_{IN}	3.5	3.7	3.9	V
		Falling V_{IN}	3.3	3.5	3.7	V
	Hysteresis			0.2		V
I_{SD}	Shut down current from V_{IN}	$V_{IN} = 12\text{ V}$, $V_{DIM} = 0\text{ V}$		1	3	μA
I_{DISC}	Discharge current from SW and BOOT	V_{IN} floating, $V_{DIM} = 0\text{ V}$		1	3	μA
I_{OP}	Normal operating current	$V_{DIM} = 3.3\text{ V}$		0.5	1	mA
DIMMING						
V_{DIM_L}	Low-level input voltage				0.3	V
V_{DIM_H}	High-level input voltage		0.65			V
V_{ANA}	Analog dimming range (TPS92200D1 only)		0.65		1.2	V
t_{DIM_ON1}	DIM minimum on time to enable device (TPS92200D2 only)	$V_{DIM} = 3.3\text{ V}$		190	300	nS
t_{DIM_ON2}	DIM minimum on time when PWM dimming (TPS92200D2 only)	$V_{DIM} = 3.3\text{ V}$			150	nS
t_{DIM_OFF}	DIM minimum off time to disable device	$V_{DIM} = 0\text{ V}$		36		mS
FEEDBACK AND ERROR AMPLIFIER						
V_{FB_REF}	FB pin reference voltage	$V_{DIM} = 3.3\text{ V}$	96	99	102	mV
V_{FB_OVP}	FB pin over voltage protection threshold	$V_{DIM} = 3.3\text{ V}$		140		mV
V_{FB_DMAX}	FB reference voltage when maximum dimming input (TPS92200D1 only)	$V_{DIM} = 1.2\text{ V}$		99		mV
V_{FB_DMIN}	FB reference voltage when minimum dimming input (TPS92200D1 only)	$V_{DIM} = 0.65\text{ V}$		5		mV
	FB reference voltage when minimum dimming duty cycle (TPS92200D2 only)	DIM pin duty cycle $\leq 3\%$		1		mV
POWER STAGE						
R_{HS}	High-side FET on resistance	$V_{IN} \geq 5\text{ V}$		150		$\text{m}\Omega$
R_{LS}	Low-side FET on resistance	$V_{IN} \geq 5\text{ V}$		90		$\text{m}\Omega$
CURRENT LIMIT						
I_{LIM_HS}	High-side current limit		2.9	3.3	4	A
$I_{LIM_LS_SOUR}$	Low-side sourcing current limit		2.4	3	3.6	A
$I_{LIM_LS_SINK}$	Low-side sinking current limit		1.4	1.8	2.4	A
THERMAL PROTECTION						
T_{TSD}	Thermal shutdown temperature			165		$^{\circ}\text{C}$
	Hysteresis			15		$^{\circ}\text{C}$

6.6 Timing Requirements

		MIN	TYP	MAX	UNIT
Auto-Retry Timing					
t _{RETRY_ON}	Auto-retry on-time		512		Cycles
t _{RETRY_OFF}	Auto-retry off-time		60		ms
SOFT START					
t _{SS}	Internal soft-start time		0.5		ms

Switching Characteristics

T_J = -40°C to +125°C, V_{IN} = 4V to 30V, (unless otherwise noted).

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
f _{sw}	Switching frequency		0.8	1	1.2	MHz
D _{MAX}	Maximum duty cycle			99%		
t _{MIN_ON}	Minimum on time			75	100	ns
t _{MIN_OFF}	Minimum off time			65	90	ns
t _{MAX_ON}	Maximum on time			6.6		us

6.7 Typical Characteristics

$V_{IN} = 12\text{ V}$, unless otherwise specified.

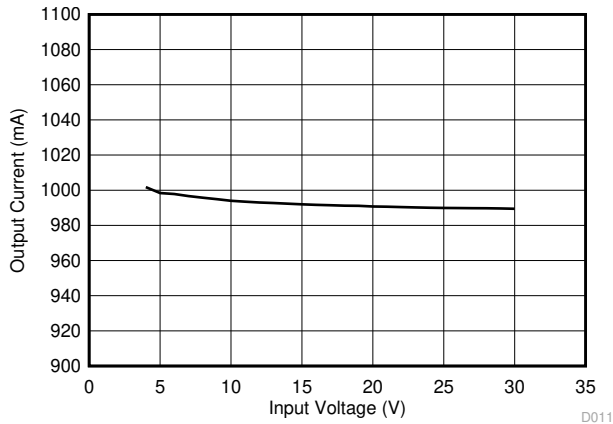


图 6-1. Output Current vs Input Voltage

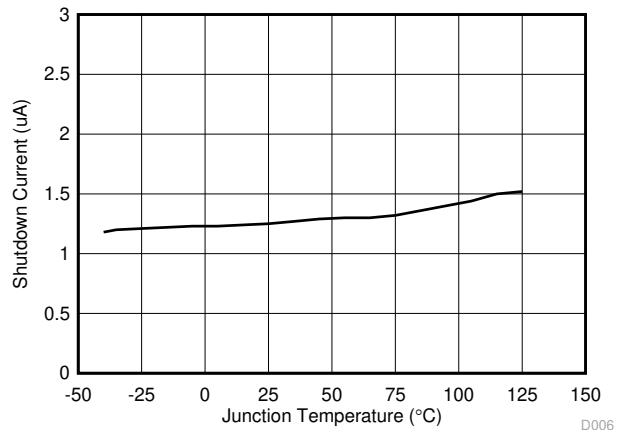


图 6-2. Shutdown Current vs Junction Temperature

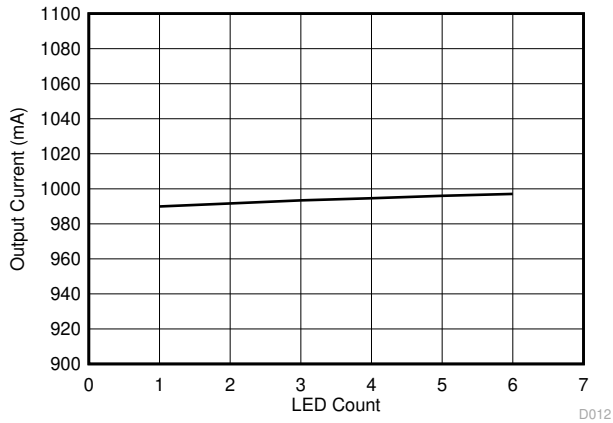


图 6-3. Output Current vs LED Count

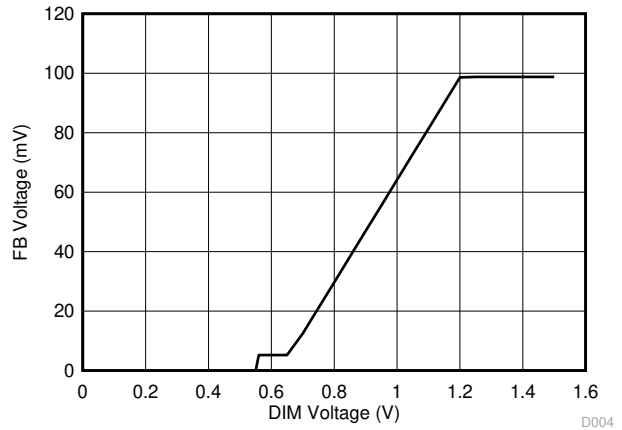


图 6-4. DIM Voltage vs FB Voltage in Analog Dimming (for TPS92200D1)



图 6-5. DIM Duty Cycle vs FB Voltage in Analog Dimming (for TPS92200D2)

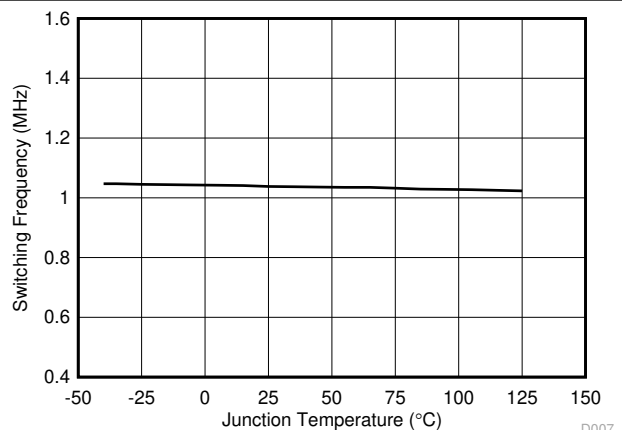


图 6-6. Switching Frequency vs Junction Temperature

6.7 Typical Characteristics (continued)

$V_{IN} = 12\text{ V}$, unless otherwise specified.

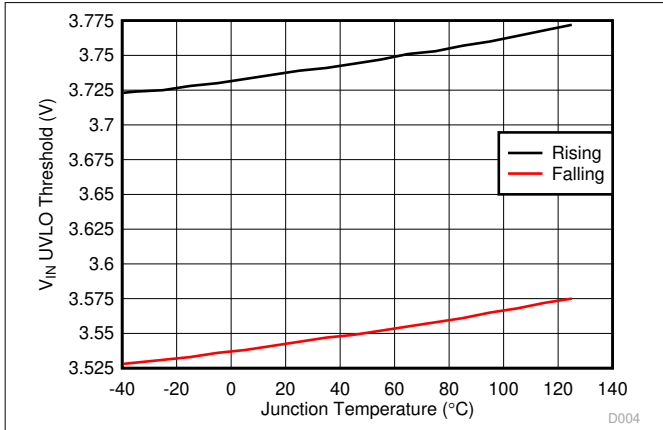


图 6-7. VIN UVLO Threshold vs Junction Temperature

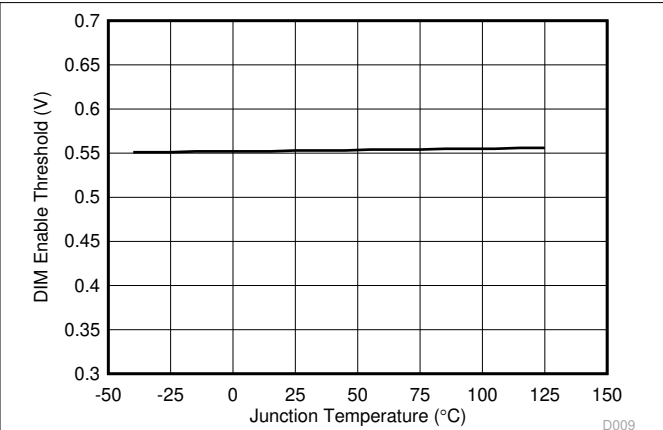


图 6-8. DIM Enable Threshold vs Junction Temperature

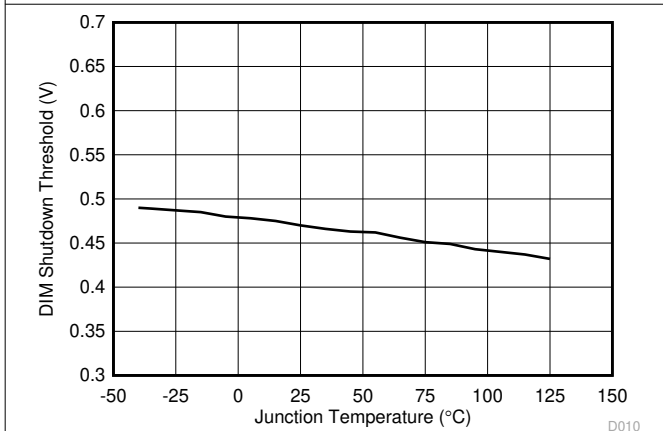


图 6-9. DIM Shutdown Threshold vs Junction Temperature

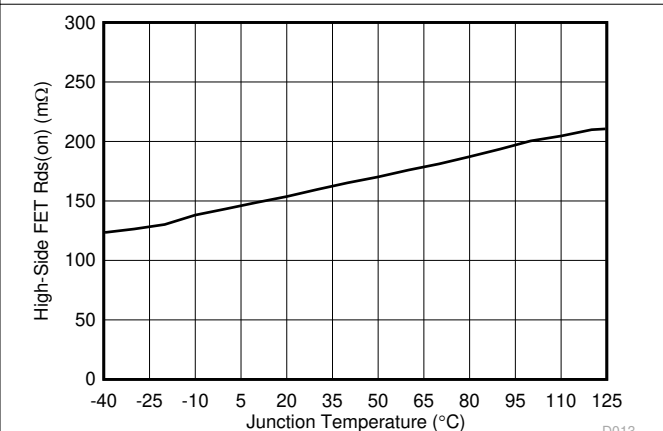


图 6-10. High-side FET On Resistance vs Junction Temperature

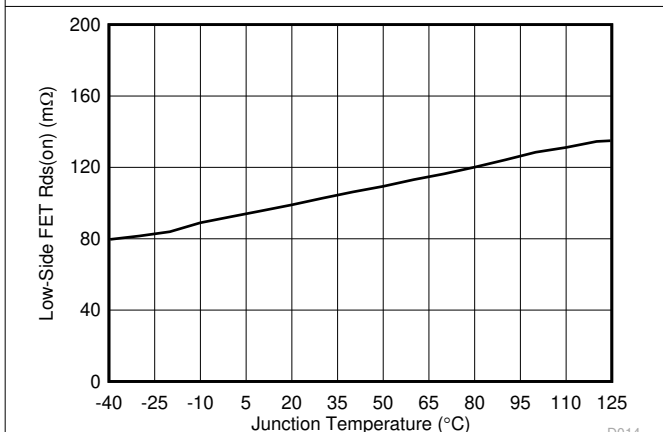


图 6-11. Low-Side FET On Resistance vs Junction Temperature

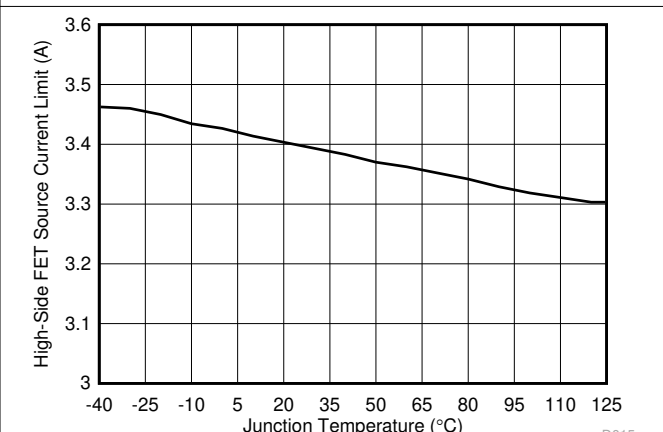


图 6-12. High-Side FET Source Current Limit vs Junction Temperature

6.7 Typical Characteristics (continued)

$V_{IN} = 12\text{ V}$, unless otherwise specified.

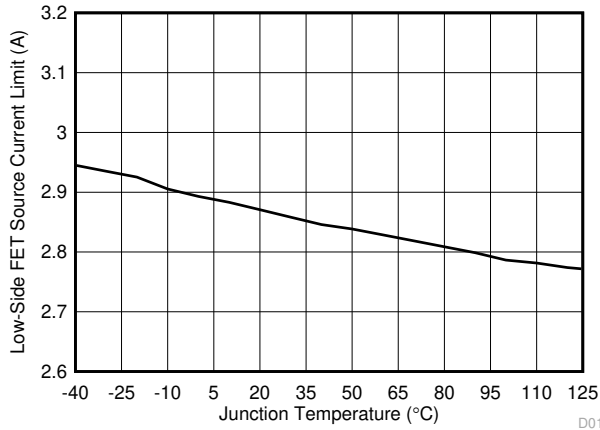


图 6-13. Low-Side FET Source Current Limit vs Junction Temperature

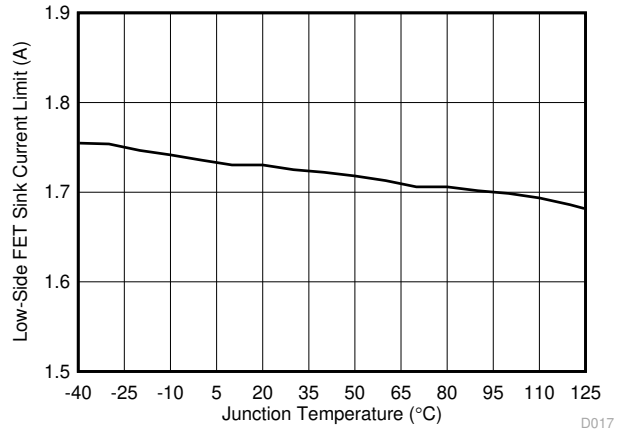


图 6-14. Low-Side FET Sink Current Limit vs Junction Temperature

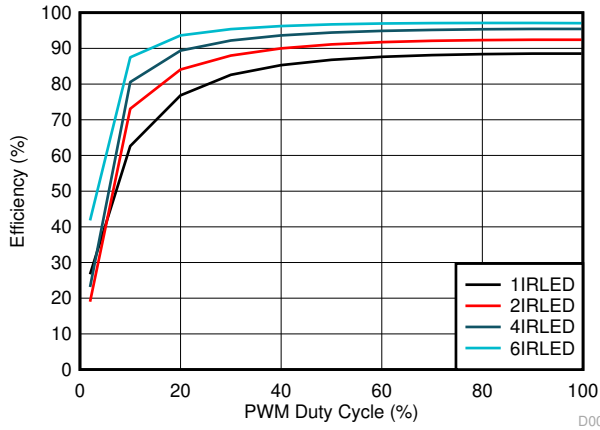


图 6-15. Efficiency at 1-A Output Current, 4.7-µH Inductor, 12-V Input Voltage

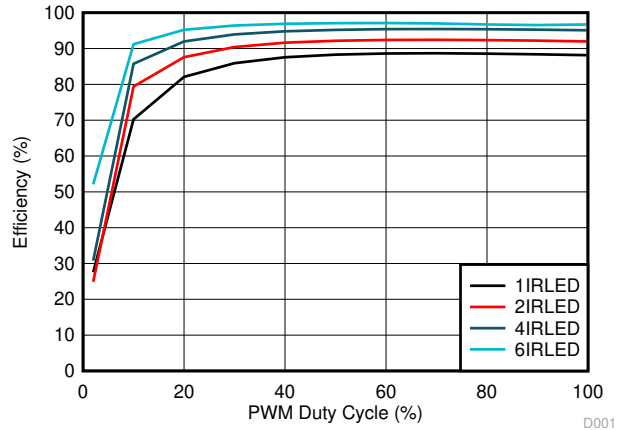


图 6-16. Efficiency at 1.5-A Output Current, 4.7-µH Inductor, 12-V Input Voltage

7 Detailed Description

7.1 Overview

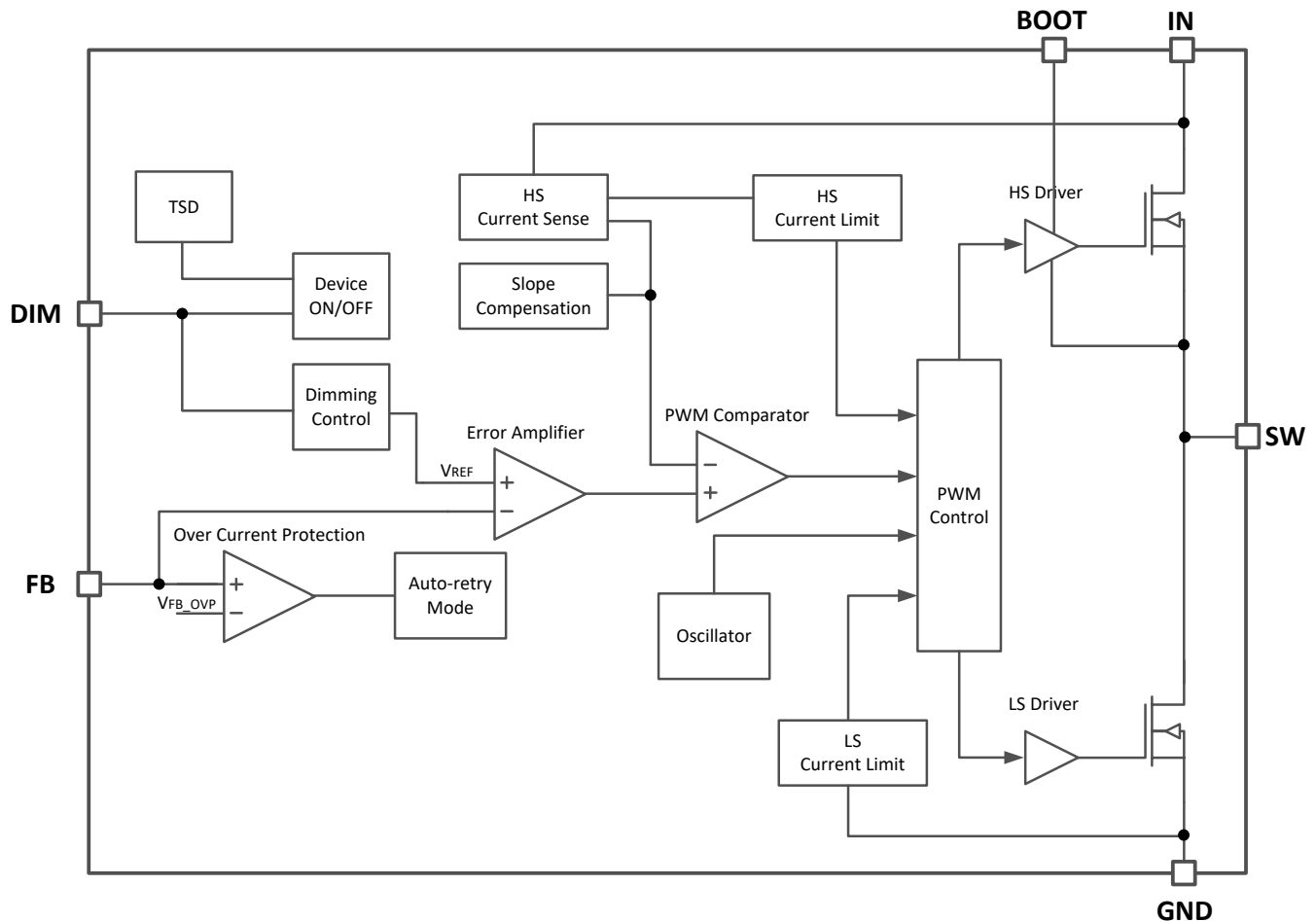
The TPS92200 device is a 1.5-A synchronous buck LED driver with 30-V maximum input voltage. By integrating the high-side and low-side NMOS switches, the TPS92200 device provides high power density with high efficiency in an ultra-small solution size.

The TPS92200 device is fully internally compensated without additional external components, which enables a simple design on a limited board space. The device uses peak current mode control to regulate the LED current with high accuracy. Switching frequency is internally set to 1 MHz, allowing the use of extremely small surface-mount inductors and chip capacitors.

The TPS92200 devices support flexible dimming methods. TPS92200D1 implement both PWM and analog dimming modes. In PWM dimming mode, the LED turns on and off according to PWM duty cycle periodically. The device's analog dimming mode is achieved by changing the internal reference voltage proportional to the voltage level of the analog input in 5% to 100% range. TPS92200D2 implement deeper analog dimming by changing the internal reference voltage proportional to the duty cycle of the PWM signal input in 1% to 100% range.

For safety and protection, the TPS92200 devices implement full protections include LED open, LED+ short-to-GND, LED short, sense resistor open and short, and device thermal protection. Hiccup mode is triggered at current limit or FB pin overvoltage scenario to avoid the device overheats.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Peak-Current-Mode PWM Control

The TPS92200 device uses peak-current-mode control and full internal compensation to provide high transient response performance over a wide range of operating conditions. The switching frequency is internally set to 1 MHz when the minimum off time $t_{\text{MIN_OFF}}$ is not triggered, thus minimizing the external inductor and capacitor size.

During each switching cycle, when the high-side power switch is turned on, the load current is sensed through the external sense resistor, R_{SENSE} . The sensed voltage on the FB pin is compared with the internal voltage reference, V_{REF} , through the error amplifier. The output of the error amplifier, V_{COMP} , is compared with the real-time current, $I_{\text{HS_SENSE}}$, going through the high-side power switch. Slope compensation circuitry is implemented in the device to prevent sub-harmonic oscillations as the duty cycle increases in peak-current-control mode. When the peak value of $V_{\text{HS_SENSE}}$ reaches V_{COMP} in the PWM comparator, the high-side power switch is turned off and the low-side NMOS is turned on at the same time. The low-side power switch stays turned on until the end of the PWM cycle. Thus, by regulating the real-time peak current in each switching cycle, the device controls the load current at the target value.

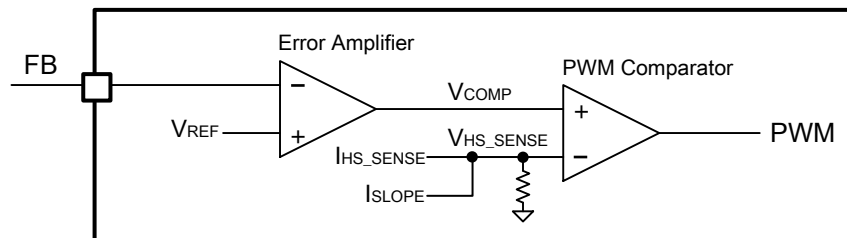


图 7-1. Error Amplifier and PWM Comparator

7.3.2 Setting LED Current

The LED current is set by the external resistor between the LEDs cathode and GND. Because the FB pin voltage reference $V_{\text{FB_REF}}$ is fixed at 99 mV, the sensing resistor can be calculated using [方程式 1](#).

$$R_{\text{SENSE}} = \frac{V_{\text{FB_REF}}}{I_{\text{LED}}} \quad (1)$$

7.3.3 Internal Soft Start

The TPS92200 device implements the internal soft-start function. The V_{REF} ramps smoothly during the soft-start period. The internal soft-start period is set as t_{SS} , 0.5 ms typically.

7.3.4 Input Undervoltage Lockout

The device implements internal Undervoltage Lockout (UVLO) circuitry on the IN pin. The device is disabled when the IN pin voltage falls below the internal IN UVLO threshold, 3.5-V typical. The internal IN UVLO threshold has a hysteresis of 0.2-V typical.

7.3.5 Bootstrap Regulator

The TPS92200 integrates a bootstrap regulator inside, and requires an external capacitor between the BOOT and SW pins to provide the gate driver voltage for the high-side power switch. TI recommends a 0.1- μF ceramic capacitor with an X7R or X5R dielectric because of the stable characteristics over temperature and voltage.

7.3.6 Maximum Duty Cycle

For a buck LED driver, the maximum duty cycle is limited by the minimum off time $t_{\text{MIN_OFF}}$ and switching frequency. To achieve the maximum brightness when the input voltage is close to output voltage, the TPS92200 device has a mechanism to decrease the switching frequency. This mechanism extends the on-time up to $t_{\text{MAX_ON}}$, 6.6 μs (typical). With this function, the TPS92200 device maximum duty cycle is able to go up to D_{MAX} , 99% (typical).

7.3.7 Overcurrent Protection

The device is protected from overcurrent conditions by cycle-by-cycle current limiting on both the high-side NMOS and the low-side NMOS.

7.3.7.1 High-Side MOSFET Overcurrent Protection

During each switching on cycle, the high-side sense voltage, V_{HS_SENSE} , is compared with V_{COMP} to generate the PWM duty cycle. To prevent an overcurrent stress, V_{COMP} is internally clamped to set the high-side NMOS current limit as I_{LIM_HS} . When the peak of I_{HS_SENSE} exceeds I_{LIM_HS} , the high-side MOSFET is turned off and the low-side MOSFET is turned on accordingly. An auto-retry mechanism is implemented for this case, if an output overcurrent condition occurs for more than auto-retry on time t_{RETRY_ON} , which is programmed for 512 switching cycles, the device shuts down for an auto-retry off-time t_{RETRY_OFF} , which is 60 ms typically.

7.3.7.2 Low-Side MOSFET Sourcing Overcurrent Protection

During each switching off-cycle, the low-side MOSFET is turned on and the conduction current is monitored by the internal circuitry. At the end of every clock cycle, the low-side MOSFET sourcing current is compared to the internally set low-side sourcing-current limit, $I_{LIM_LS_SOUR}$. If the low-side sourcing-current limit is exceeded, the high-side MOSFET does not turn on and the low-side MOSFET stays on for the next clock cycle. The high-side MOSFET turns on again when the low-side current is below the low-side sourcing current limit at the start of a cycle.

7.3.7.3 Low-Side MOSFET Sinking Overcurrent Protection

During each switching off-cycle, the device also monitors the sinking current of the low-side MOSFET by detecting the voltage across it and setting a sinking overcurrent limit, $I_{LIM_LS_SINK}$, to protect the low-side power switch from overstress. When the peak of the sinking current reaches $I_{LIM_LS_SINK}$, both the high-side MOSFET and low-side MOSFET are turned off. The high-side MOSFET turns on again when the low-side current is below the low side sinking current-limit at the start of a new cycle.

7.3.8 Fault Protection

The device is protected from several kinds of fault conditions, such as LED open and short, sense resistor open and short, and thermal shutdown.

表 7-1. Protections

TYPE	CRITERION	BEHAVIOR
LED open load	V_{FB} close to 0 mV	The device keeps maximum duty cycle turn-on.
LED+ and LED - short circuit	$V_{FB} > V_{FB_OVP}$	When $V_{FB} > V_{FB_OVP}$, the device keeps the minimum on-time, and starts the auto-retry timer. During the auto-retry mode, the device is protected by the overcurrent limits.
LED+ short-to-GND	High-side or low-side NMOS current limit triggered	When the high-side or low-side MOSFET current limit is triggered, the device starts the auto-retry timer.
Sense-resistor open load	$V_{FB} > V_{FB_OVP}$	When $V_{FB} > V_{FB_OVP}$, the device keeps the minimum on-time, and starts the auto-retry timer.
Sense-resistor short circuit to GND	High-side or low-side MOSFET current limit triggered	When the high-side or low-side MOSFET current limit is triggered, the device starts the auto-retry timer.
Thermal shutdown	$T_J > T_{TSD}$	Disable the device when $T_J > T_{TSD}$, re-activate the device when T_J falls below the hysteresis level.

7.3.8.1 LED Open-Load Protection

When LED load is open, V_{FB} voltage is low. The internal error amplifier output voltage, V_{COMP} , is driven high and clamped. The high-side MOSFET is forced to turn on with the maximum PWM duty cycle, D_{MAX} .

7.3.8.2 LED+ and LED - Short Circuit Protection

When LED+ and LED - are shorted, V_{FB} is higher than internal reference voltage, V_{REF} , and internal error amplifier output voltage V_{COMP} is driven low and clamped. The high-side MOSFET is forced to turn on with the minimum on-time each cycle, t_{MIN_ON} . In this case, if the output voltage is too low, the inductor current cannot balance in a cycle, causing current runaway. Finally, the inductor current is clamped by low-side MOSFET sourcing current limit $I_{LIM_LS_SOUR}$ which is 3-A typical. If V_{FB} rises higher than V_{FB_OVP} , the device starts the auto-retry timer. After the counter, t_{RETRY_ON} , expires, the device shuts down and starts another counter, t_{RETRY_OFF} . During the shutdown period, both high-side and low-side MOSFETs are turned off. After the hiccup timer expires, TPS92200 restarts again. The device repeats these behaviors until the failure condition is removed. During the auto-retry mode, the device is also protected by the overcurrent limits of both high-side power switch and low-side power switch.

7.3.8.3 LED+ Short Circuit to GND Protection

When LED+ is shorted to GND, V_{FB} is low and V_{COMP} is driven high and clamped. The high-side MOSFET is forced to turn on with maximum PWM duty cycle, after either the high-side or low-side overcurrent limit is triggered, the device starts the auto-retry counter. When the counter t_{RETRY_ON} expires, the device shuts down and starts another counter t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed.

7.3.8.4 Sense-Resistor Open-Load Protection

When the R_{SENSE} load is open, V_{FB} is higher than V_{REF} , and V_{COMP} is driven low and clamped. The high-side NMOS is forced to turn on with the minimum on-time each cycle, t_{MIN_ON} . If V_{FB} rises higher than V_{FB_OVP} , the device starts the auto-retry timer. After the counter t_{RETRY_ON} expires, the device shuts down and starts another counter t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed. To prevent the FB pin from overvoltage damage during the t_{RETRY_ON} period, the FB pin implements a comparator with a 1-V threshold. If $V_{FB} > 1$ V, both high-side and low-side NMOSs are switched off immediately and the t_{RETRY_OFF} counter starts.

7.3.8.5 Sense Resistor Short Circuit-to-GND Protection

When R_{SENSE} is shorted to GND, V_{FB} is low and V_{COMP} is driven high and clamped. After the current reaches either the high-side overcurrent limit or low-side overcurrent limit, the device starts the auto-retry counter. After the t_{RETRY_ON} counter expires, the device shuts down and starts another counter, t_{RETRY_OFF} . During the shutdown period, both high-side and low-side NMOSs are switched off. The device repeats these actions until the failure condition is removed.

7.3.8.6 Overvoltage Protection

When the FB pin, for some reason, has a voltage higher than 1-V applied, the device shuts down immediately. Both high-side and low-side MOSFETs are kept off, and the device starts the auto-retry counter, t_{RETRY_OFF} . When the counter t_{RETRY_OFF} expires, the device restarts again. If the failure still exists, TPS92200 repeats above hiccup shutdown and restart process.

7.3.8.7 Thermal Shutdown

The TPS92200 device implements a thermal shutdown mechanism to protect the device from damage due to overheating. When the junction temperature rises to 160°C (typical), the device shuts down immediately. The TPS92200 device releases thermal shutdown when the junction temperature of the device is reduced to 145°C (typical).

7.4 Device Functional Modes

表 7-2. Functional Modes

Device Name	DIM Pin Constant High	DIM Pin Constant Low	Dimming Input Type	Dimming Output Type
TPS92200D1	Device full on	Device turned off	Digital signal • Amplitude: $V_H > 1.4\text{ V}$ and $V_L < 0.3\text{ V}$ • Frequency: 100 Hz – 2 kHz	PWM Dimming
			Analog voltage • Amplitude: 0.65 V – 1.2 V	5% – 100% Analog Dimming
TPS92200D2			Digital signal • Frequency: 20 kHz – 200 kHz	1% – 100% Analog Dimming

7.4.1 Enable and Disable the Device

The DIM pin performs not only the dimming function, but also the enable-and-disable function. When the V_{IN} voltage is above the UVLO threshold, the TPS92200 device can be enabled by driving the DIM pin higher than the threshold voltage V_{DIM_H} for a period longer than t_{DIM_ON1} . To disable the device, the DIM pin must be kept lower than the threshold voltage V_{DIM_L} for a period longer than t_{DIM_OFF} . External pulldown is required to set the device as default-disabled, because the DIM pin is designed as a high-impedance input.

7.4.2 TPS92200D1 PWM Dimming

For the TPS92200D1 version, when applying a digital signal on the DIM pin, the device enters into PWM dimming mode. The amplitude of the digital signal must be higher than 1.4 V for high level and less than 0.3 V for low level, which is out of the analog dimming range (0.65 V – 1.2 V). TI recommends the frequency of the digital signal be from 100 Hz to 2 kHz to achieve good dimming accuracy. In PWM dimming mode, the output turns on and off simultaneously with the digital-input high and low pulses, respectively.

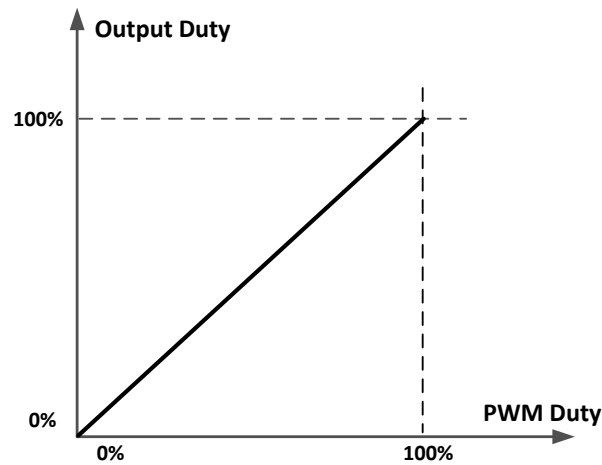


图 7-2. TPS92200D1 PWM Dimming

7.4.3 TPS92200D1 Analog Dimming

For the TPS92200D1 version, when applying an analog voltage on the DIM pin and the amplitude is between 0.65 V and 1.2 V, the device enters into analog dimming mode, and the reference voltage V_{REF} is changed proportionally to the analog input level. When $V_{DIM} = 0.65\text{ V}$, the reference voltage is 5 mV. When $V_{DIM} = 1.2\text{ V}$, the reference voltage is 99 mV.

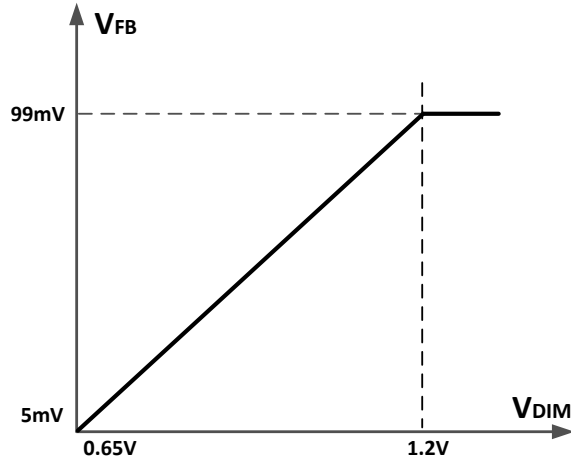


图 7-3. TPS92200D1 Analog Dimming

7.4.4 TPS92200D2 Analog Dimming

The TPS92200D2 version supports accurate analog dimming with a digital signal. When applying a digital signal on the DIM pin, the device enters into analog dimming mode, and the reference voltage V_{REF} is changed proportionally to the duty cycle of digital input. The frequency of the digital signal must be within the range of 20 kHz to 200 kHz.

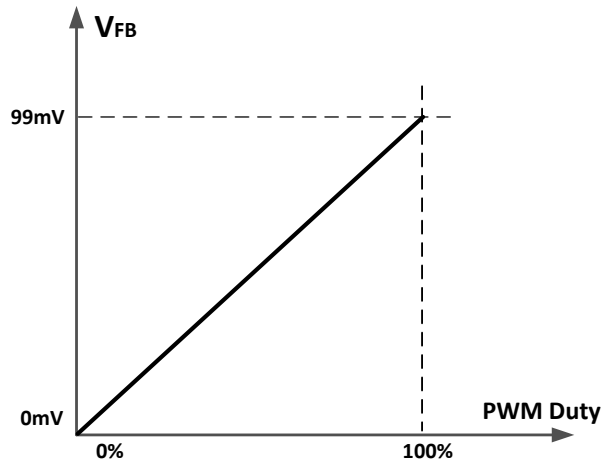


图 7-4. TPS92200D2 Analog Dimming

8 Application and Implementation

备注

以下应用部分中的信息不属于 TI 器件规格的范围，TI 不担保其准确性和完整性。TI 的客户应负责确定器件是否适用于其应用。客户应验证并测试其设计，以确保系统功能。

8.1 Application Information

The TPS92200 device is typically used as a buck converter to drive one or more LEDs from a 4-V to 30-V input.

8.2 Typical Application

8.2.1 TPS92200D1 12-V Input, 1.5-A, 2-Piece IR LED Driver With Analog Dimming

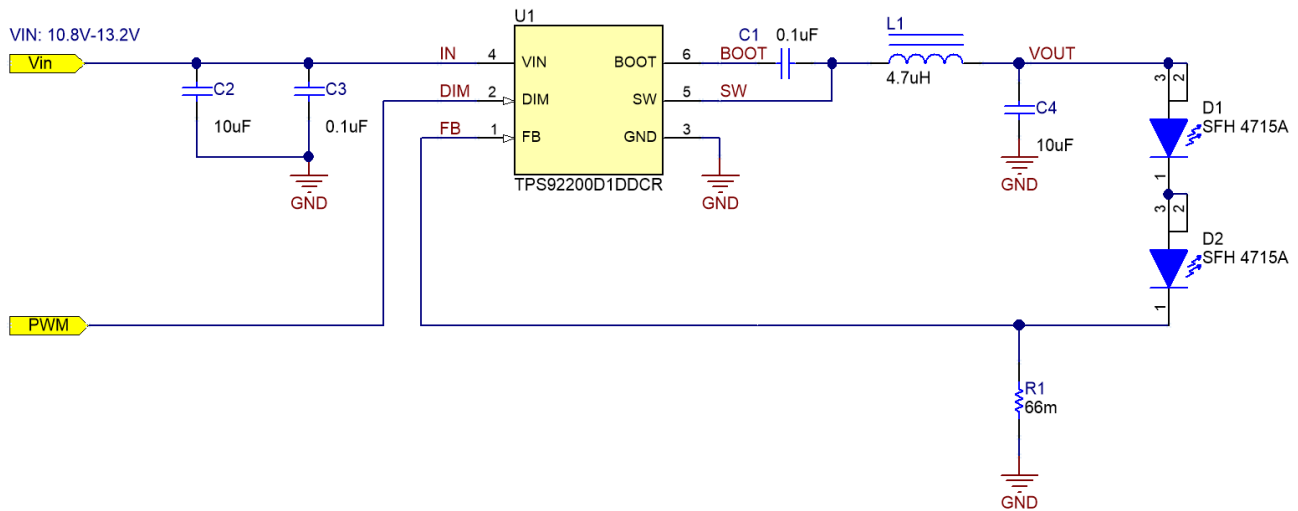


图 8-1. 12-VIN, 1.5-A, 2-piece IR LED, Analog Dimming Reference Design

8.2.1.1 Design Requirements

For this design example, use the parameters in the following table.

表 8-1. Design Parameters

PARAMETER	VALUE
Input voltage range	12 V \pm 10%
LED forward voltage	1.75 V
Output voltage	3.6 V ($1.75 \times 2 + 0.1$)
Maximum LED current	1.5 A
Inductor current ripple	30% of maximum LED current
LED current ripple	20 mA or less
Input voltage ripple	200 mV or less
Dimming type	Analog dimming with TPS92200D1: 0.65-V to 1.2-V analog input on DIM pin

8.2.1.2 Detailed Design Procedure

8.2.1.2.1 Inductor Selection

Use 方程式 2 to calculate the recommended value of the output inductor L.

$$L = \frac{V_{OUT} \times (V_{VIN(max)} - V_{OUT})}{V_{VIN(max)} \times K_{IND} \times I_{LED} \times f_{SW}} \quad (2)$$

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across the LED load and the voltage across the sense resistor.

In general, the value of K_{IND} is suggested between 0.2 and 0.4. For the application that can tolerate higher LED current ripple or use larger output capacitors, one can choose 0.4 for K_{IND} , otherwise, smaller K_{IND} like 0.2 can be chosen to get smaller LED current ripple.

With the chosen inductor value, the user can calculate the actual inductor current ripple using [方程式 3](#).

$$I_{L(ripple)} = \frac{V_{OUT} \times (V_{VIN(max)} - V_{OUT})}{V_{VIN(max)} \times L \times f_{SW}} \quad (3)$$

For TPS92200, TI suggests that the inductor current ripple be larger than 300 mA to assure loop stability. If the calculated inductor current ripple is less than 300 mA, TI suggests a smaller inductor.

The inductor RMS current and saturation-current ratings must be greater than those seen in the application. These ratings ensure that the inductor does not overheat or saturate. During power up, transient conditions, or fault conditions, the inductor current can exceed its normal operating current. For this reason, the most conservative approach is to specify an inductor with a saturation current rating equal to or greater than the converter current limit. This action is not always possible due to application size limitations. The peak-inductor-current and RMS current equations are shown in [方程式 4](#) and [方程式 5](#).

$$I_{L(peak)} = I_{LED} + \frac{I_{L(ripple)}}{2} \quad (4)$$

$$I_{L(rms)} = \sqrt{I_{LED}^2 + \frac{I_{L(ripple)}^2}{12}} \quad (5)$$

In this design, $V_{IN(max)} = 13.2$ V, $V_{OUT} = 3.6$ V, $I_{LED} = 1.5$ A, choose $K_{IND} = 0.3$, the calculated inductance is 5.8- μ H. A 4.7- μ H inductor is chosen. With this inductor, the ripple, peak, and RMS currents of the inductor are 0.56 A, 1.78 A and 1.51 A respectively. The chosen inductor has ample margin.

8.2.1.2.2 Input Capacitor Selection

The device requires an input capacitor to reduce the surge current drawn from the input supply and the switching noise from the device. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10- μ F capacitor with an additional 0.1- μ F capacitor from VIN to GND to provide additional high-frequency filtering is enough. The input capacitor voltage rating must be greater than the maximum input voltage.

In this design, a 10- μ F, 35-V X7R ceramic capacitor is chosen. This yields around 40-mV input ripple voltage.

8.2.1.2.3 Output Capacitor Selection

The output capacitor reduces the high-frequency ripple current through the LED string. Various guidelines disclose how much high-frequency ripple current is acceptable in the LED string. Excessive ripple current in the LED string increases the RMS current in the LED string, and therefore the LED temperature also increases.

1. Calculate the total dynamic resistance of the LED string (R_{LED}) using the LED manufacturer's data sheet.

2. Calculate the required impedance of the output capacitor (Z_{OUT}) given the acceptable peak-to-peak ripple current through the LED string, I_{LED(ripple)} × I_{L(ripple)}, is the peak-to-peak inductor ripple current as calculated previously in inductor selection.
3. Calculate the minimum effective output capacitance required.
4. Increase the output capacitance appropriately due to the derating effect of applied dc voltage.

See [方程式 6](#), [方程式 7](#), and [方程式 8](#).

$$R_{LED} = \frac{\Delta V_F}{\Delta I_F} \times \# \text{ of LEDs} \quad (6)$$

$$Z_{COUT} = \frac{(R_{LED} + R_{SENSE}) \times I_{LED(ripple)}}{I_{L(ripple)} - I_{LED(ripple)}} \quad (7)$$

$$C_{OUT} = \frac{1}{2\pi \times f_{SW} \times Z_{COUT}} \quad (8)$$

After the output capacitor is chosen, [方程式 9](#) can be used to estimate the peak-to-peak ripple current through the LED string.

$$I_{LED(ripple)} = \frac{Z_{COUT} \times I_{L(ripple)}}{Z_{COUT} + R_{LED} + R_{SENSE}} \quad (9)$$

OSRAM SFH4715A IR LED is used here. The dynamic resistance of this LED is 0.29 ohm at 1.5-A forward current. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. In this design, a 10-μF, 35-V X7R ceramic capacitor is chosen, the part number is GRM32ER7YA106KA12L. The calculated ripple current of the LED is about 23.8 mA.

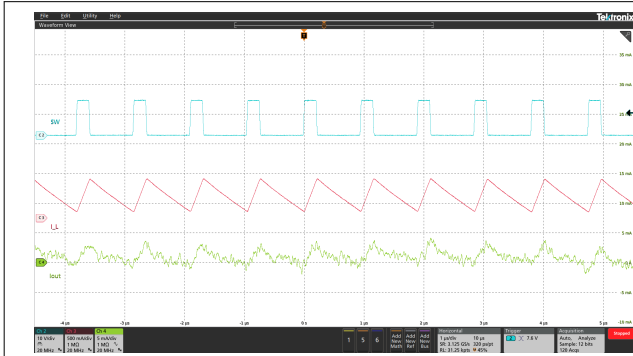
8.2.1.2.3.1 Sense Resistor Selection

The maximum LED current is 1.5 A at 100% PWM duty and the corresponding V_{REF} is 99 mV. By using [方程式 1](#), calculate the needed sense resistance at 66 mΩ. Pay close attention to the power consumption of the sense resistor in this design at 148.5 mW, and make sure the chosen resistor has enough margin in its power rating.

8.2.1.2.3.1.1 Other External Components Selection

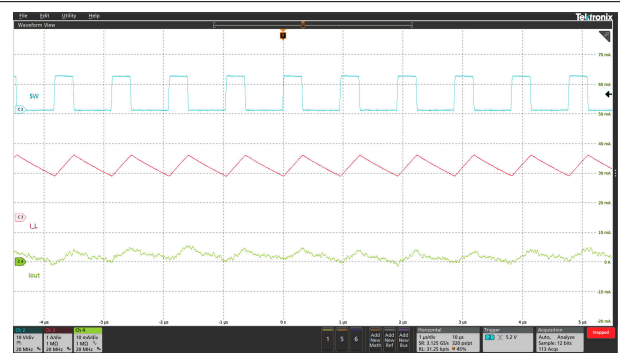
In this design, a 0.1-μF, 50-V X7R ceramic capacitor is chosen for C_{BOOT}.

8.2.1.3 Application Curves



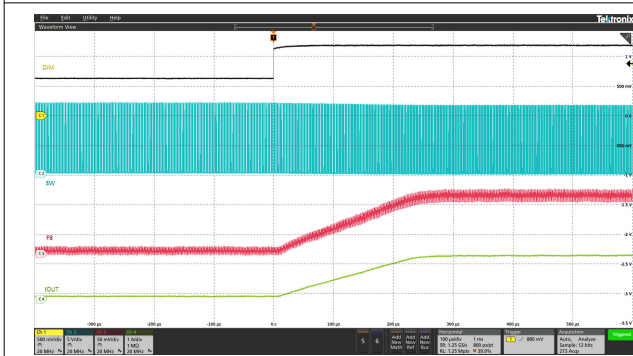
Blue: SW, Red: Inductor Current, Green: LED Current Ripple (AC)

图 8-2. LED Current Ripple at $V_{DIM} = 0.65\text{ V}$



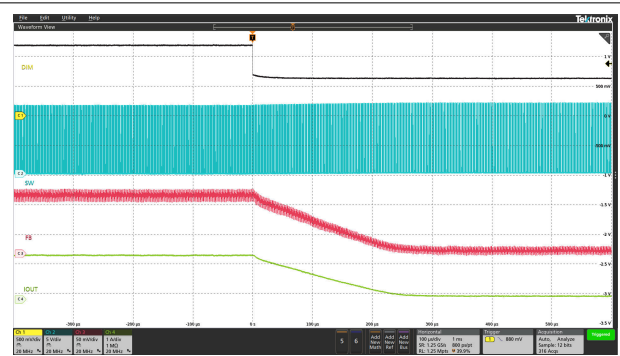
Blue: SW, Red: Inductor Current, Green: LED Current Ripple (AC)

图 8-3. LED Current Ripple at $V_{DIM} = 1.2\text{ V}$



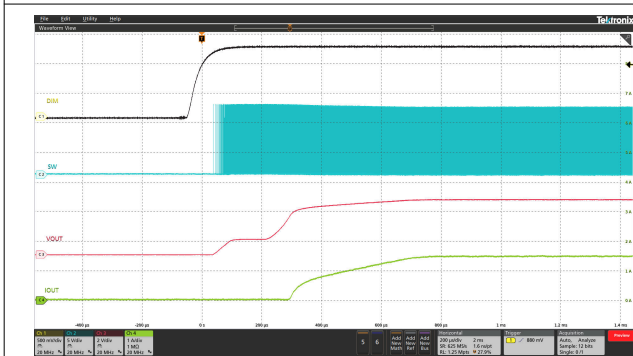
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-4. LED Current Transient for a V_{DIM} Transition From 0.65 V to 1.2 V



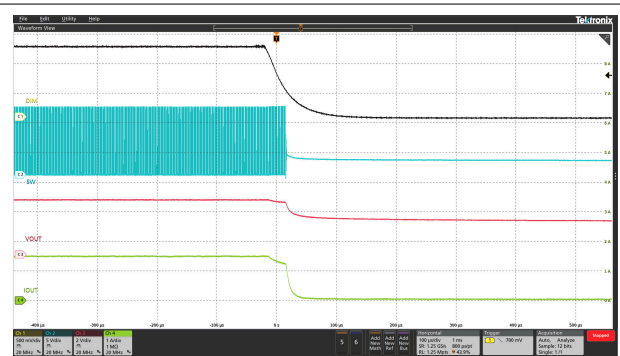
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-5. LED Current Transient for a V_{DIM} Transition From 1.2 V to 0.65 V



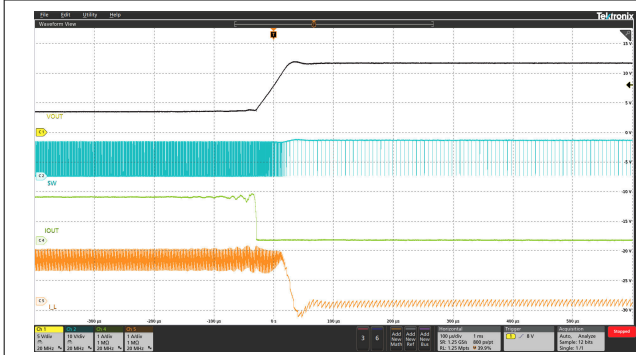
Black: DIM, Blue: SW, Red: V_OUT, Green: LED Current

图 8-6. Start-Up at $V_{DIM} = 1.2\text{ V}$



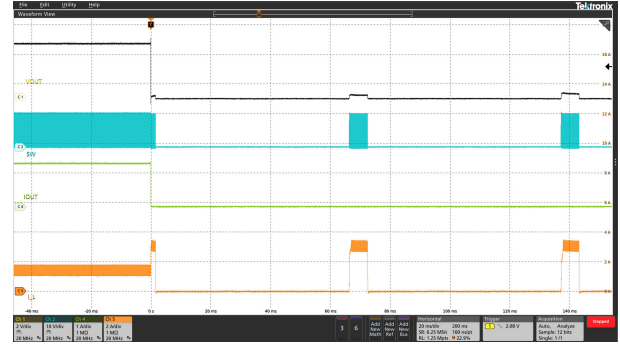
Black: DIM, Blue: SW, Red: V_OUT, Green: LED Current

图 8-7. Shutdown at $V_{DIM} = 1.2\text{ V}$



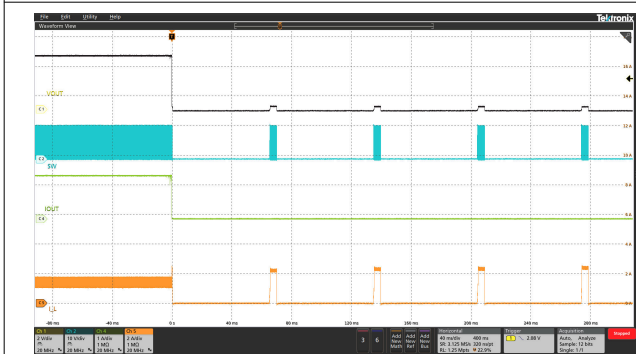
Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

图 8-8. LED Open-Load Protection



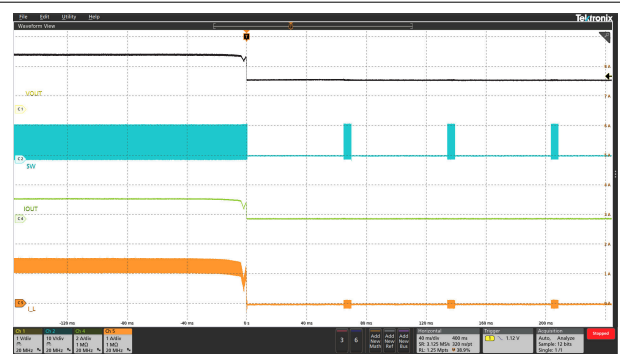
Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

图 8-9. LED+ Short-to-GND Protection



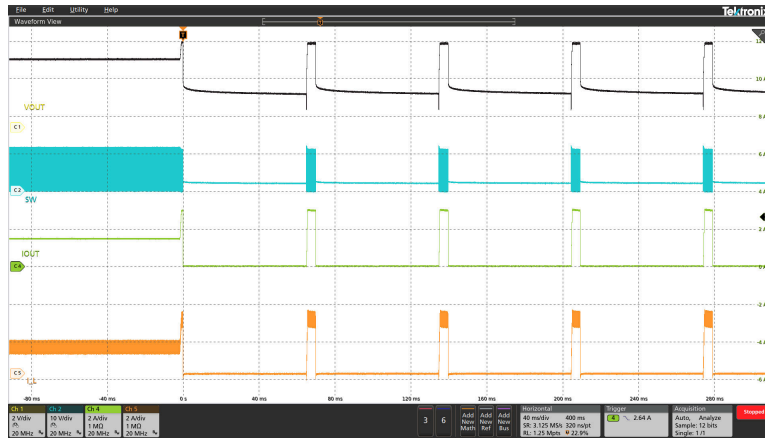
Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

图 8-10. LED+ and LED - Short Circuit-



Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

图 8-11. Sense-Resistor Open-Load Protection



Black: Vout, Blue: SW, Green: LED Current, Orange: Inductor Current

图 8-12. Sense-Resistor Short-to-GND Protection

8.2.2 TPS92200D1 24-V Input, 1-A, 6-Piece WLED Driver With PWM Dimming

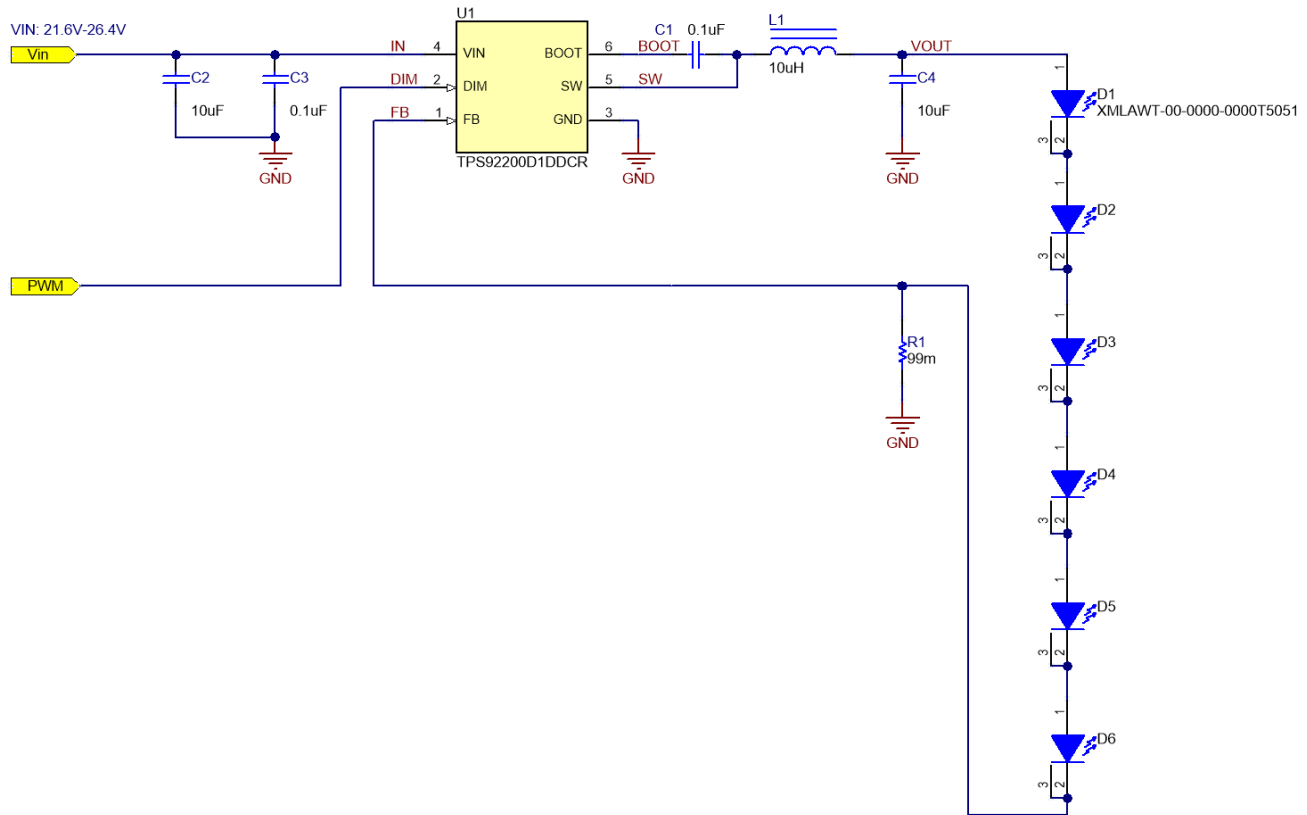


图 8-13. 24-VIN, 1-A, 6-piece WLED, PWM Dimming Reference Design

8.2.2.1 Design Requirements

For this design example, use the parameters in the following table.

表 8-2. Design Parameters

PARAMETER	VALUE
Input voltage range	24 V \pm 10%
LED forward voltage	3 V
Output voltage	18.1 V (3 \times 6 + 0.1)
Maximum LED current	1 A
Inductor current ripple	60% of maximum LED current
LED current ripple	20 mA or less
Input voltage ripple	200 mV or less
Dimming type	PWM dimming with TPS92200D1: 500 Hz, 1% to 100% duty cycle input on the DIM pin

8.2.2.2 Detailed Design Procedure

8.2.2.2.1 Inductor Selection

For this application, input voltage is 24-V rail with 10% variation, output is 6 white LEDs in series and the inductor current ripple requirement is less than 60% of maximum LED current. To choose a proper peak-to-peak inductor current ripple, the low-side FET sink current limit must not be violated when the converter works in no-load condition. This action requires the half of peak-to-peak inductor current ripple to be lower than that limit. Another consideration is the increased core loss and copper loss in the inductor with this larger peak-to-peak

current ripple which is also acceptable. After this peak-to-peak inductor current ripple is chosen, use [方程式 10](#) to calculate the recommended value of the output inductor L.

$$L = \frac{V_{OUT} \times (V_{VIN(max)} - V_{OUT})}{V_{VIN(max)} \times K_{IND} \times I_{LED} \times f_{SW}} \quad (10)$$

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor-current ripple using [方程式 11](#).

$$I_{L(ripple)} = \frac{V_{OUT} \times (V_{VIN(max)} - V_{OUT})}{V_{VIN(max)} \times L \times f_{SW}} \quad (11)$$

In this design, $V_{IN(max)} = 26.4$ V, $V_{OUT} = 18.1$ V, $I_{LED} = 1$ A, choose $K_{IND} = 0.6$, the calculated inductance is 9.49 μ H. A 10- μ H inductor is chosen. With this inductor, the ripple, peak, and rms currents of the inductor are 0.57 A, 1.29 A, and 1.01 A, respectively.

8.2.2.2.2 Input Capacitor Selection

In this design, a 10- μ F, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L, from muRata is chosen. This ceramic capacitor yields around 30-mV input-ripple voltage.

8.2.2.2.3 Output Capacitor Selection

The dynamic resistance of this Cree white LED is 0.67 ohm at 1-A forward current. In this design, choose a 10- μ F, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L. The calculated ripple current of LED is about 11.5mA.

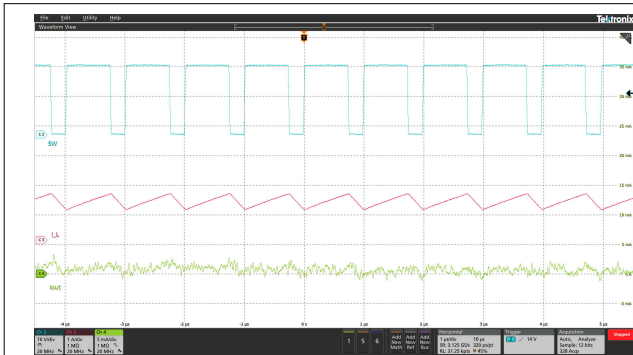
8.2.2.2.3.1 Sense Resistor Selection

The maximum LED current is 1 A, and the corresponding V_{REF} is 99 mV. Using [方程式 1](#), calculate the needed sense resistance at 99 m Ω . Pay close attention to the power consumption of the sense resistor in this design at 99 mW, and make sure the chosen resistor has enough margin in its power rating.

8.2.2.2.3.1.1 Other External Components Selection

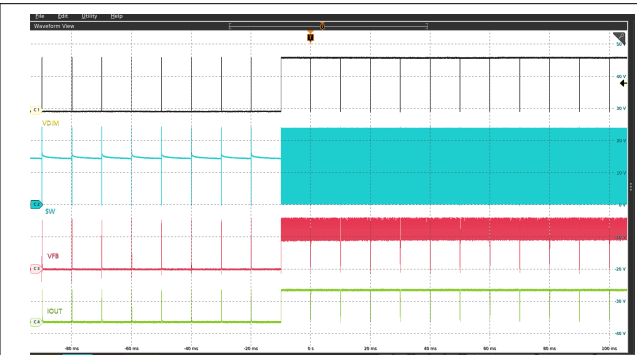
See the [Other External Components Selection](#).

8.2.2.3 Application Curves



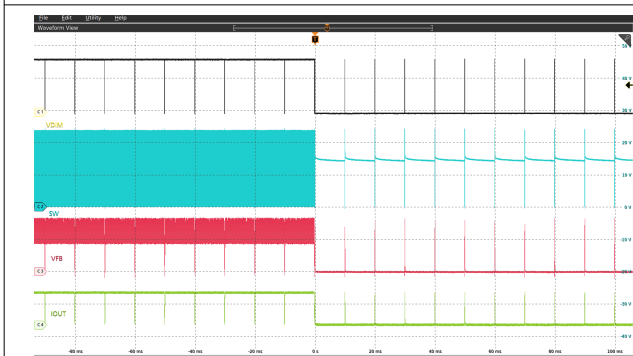
Blue: SW, Red: Inductor Current, Green: LED Current (AC)

图 8-14. LED Current Ripple at 100% Duty Cycle and 500 Hz



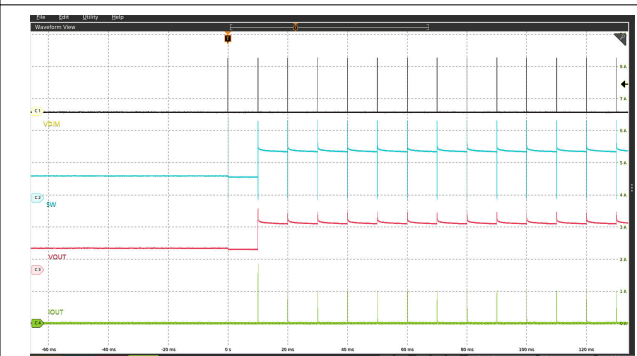
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-15. LED Current Transient From 1% to 100% Duty Cycle at 500 Hz



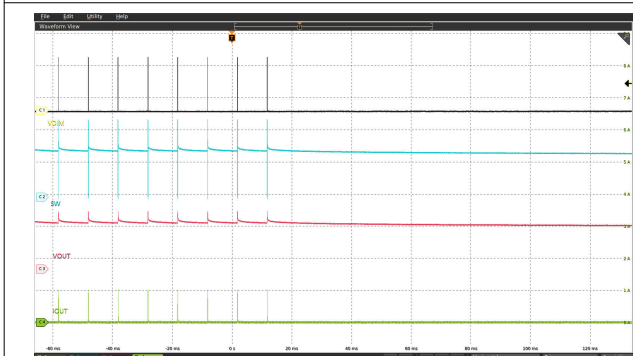
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-16. LED Current Transient From 100% to 1% Duty Cycle at 500 Hz



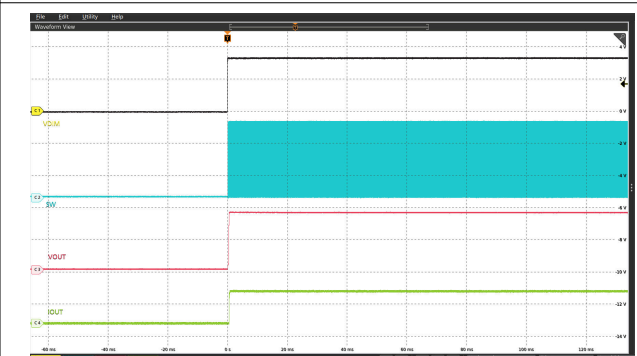
Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

图 8-17. Start-Up at 1% Duty Cycle and 500 Hz



Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

图 8-18. Shutdown at 1% Duty Cycle and 500 Hz



Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

图 8-19. Start-Up at 100% Duty Cycle and 500 Hz

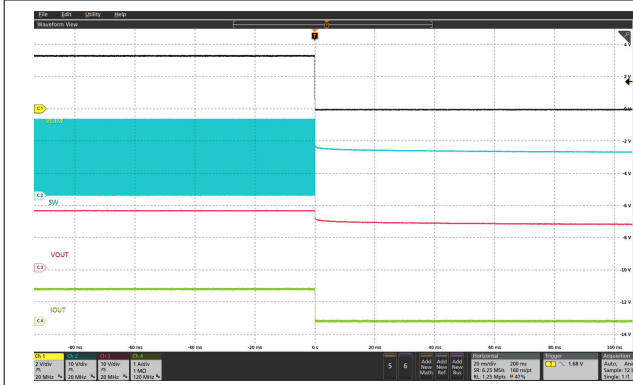
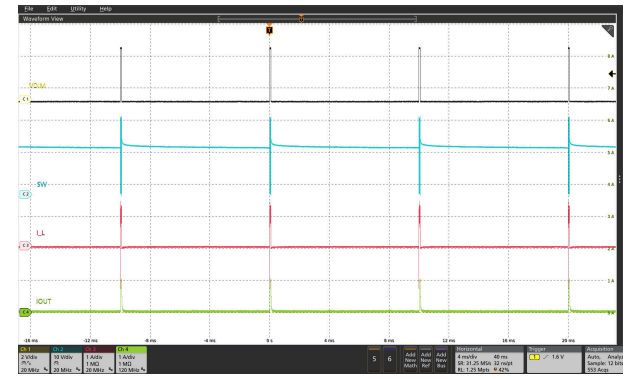
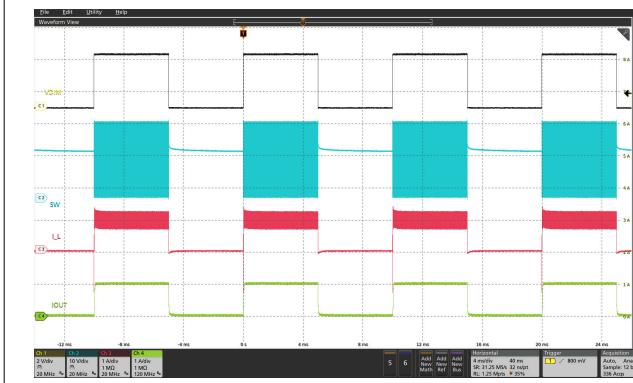


图 8-20. Shutdown at 100% Duty Cycle and 500 Hz



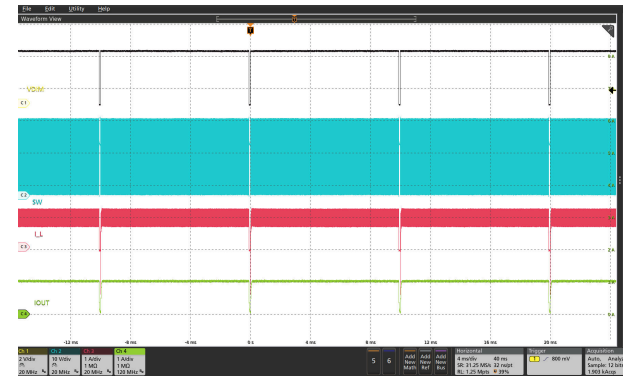
Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

图 8-21. LED PWM Dimming at 1% Duty Cycle and 200 Hz



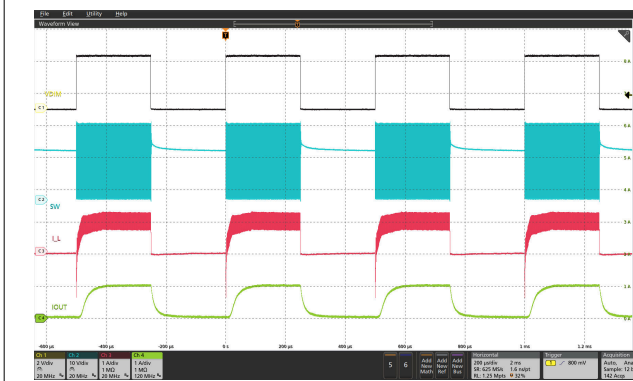
Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

图 8-22. LED PWM Dimming at 50% Duty Cycle and 200 Hz



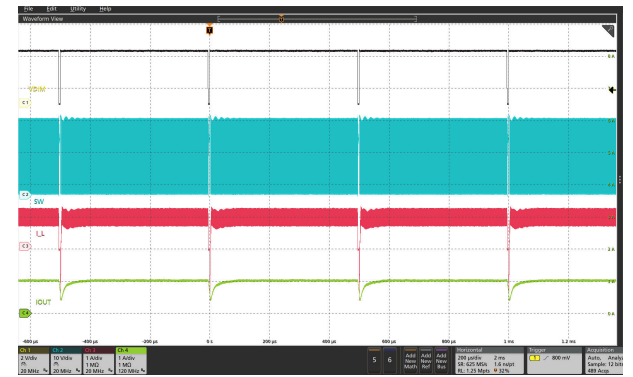
Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

图 8-23. LED PWM Dimming at 99% Duty Cycle and 200 Hz



Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

图 8-24. LED PWM Dimming at 50% Duty Cycle and 2 kHz



Black: DIM, Blue: SW, Red: Inductor Current, Green: LED Current

图 8-25. LED PWM Dimming at 99% Duty Cycle and 2 kHz

8.2.3 5-V Input, 1-A, 1-Piece IR LED Driver With TPS92200D2

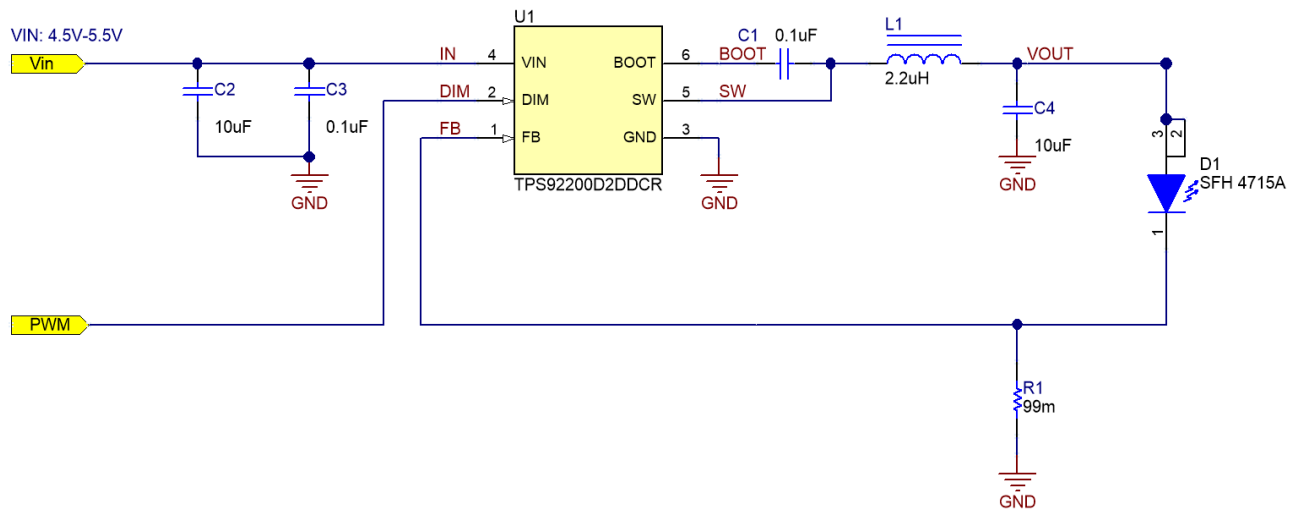


图 8-26. 5-VIN, 1-A, 1-piece IR LED, Analog Dimming Reference Design

8.2.3.1 Design Requirements

For this design example, use the parameters in the below table.

表 8-3. Design Parameters

PARAMETER	VALUE
Input voltage range	5 V ±10%
LED forward voltage	1.75 V
Output voltage	1.85 V (1.75 + 0.1)
Maximum LED current	1 A
Inductor current ripple	60% of maximum LED current
LED current ripple	20 mA or less
Input voltage ripple	200 mV or less
Dimming type	Analog dimming with TPS92200D2: 50 kHz, 1% to 100 % duty cycle input on the DIM pin

8.2.3.2 Detailed Design Procedure

8.2.3.2.1 Inductor Selection

For this application, input voltage is 5-V rail with 10% variation, output is a single IR LED, and the inductor current ripple requirement is less than 60% of maximum LED current.

Use 方程式 12 to calculate the minimum value of the output inductor (L_{MIN}).

$$L = \frac{V_{OUT} \times (V_{VIN(max)} - V_{OUT})}{V_{VIN(max)} \times K_{IND} \times I_{LED} \times f_{SW}} \quad (12)$$

where

- K_{IND} is a coefficient that represents the amount of inductor ripple current relative to the maximum LED current.
- I_{LED} is the maximum LED current.
- V_{OUT} is the sum of the voltage across LED load and the voltage across sense resistor.

With the chosen inductor value, the user can calculate the actual inductor current ripple using [方程式 13](#).

$$I_{L(\text{ripple})} = \frac{V_{OUT} \times (V_{VIN(\text{max})} - V_{OUT})}{V_{VIN(\text{max})} \times L \times f_{SW}} \quad (13)$$

In this design, $V_{IN(\text{max})} = 5.5 \text{ V}$, $V_{OUT} = 1.85 \text{ V}$, $I_{LED} = 1 \text{ A}$, choose $K_{IND} = 0.6$. The calculated inductance is $2.046 \mu\text{H}$. A $2.2\text{-}\mu\text{H}$ inductor is chosen. With this inductor, the ripple, peak, and RMS currents of the inductor are 0.56 A , 1.28 A , and 1.01 A , respectively.

8.2.3.2.2 Input Capacitor Selection

In this design, a $10\text{-}\mu\text{F}$, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12L, from muRata is chosen. This ceramic capacitor yields around 30-mV input ripple voltage.

8.2.3.2.3 Output Capacitor Selection

The dynamic resistance of this LED is 0.29 ohm at 1-A forward current. In this design, choose a $10\text{-}\mu\text{F}$, 35-V X7R ceramic capacitor, part number GRM32ER7YA106KA12. The calculated ripple current of LED is about 21.9 mA .

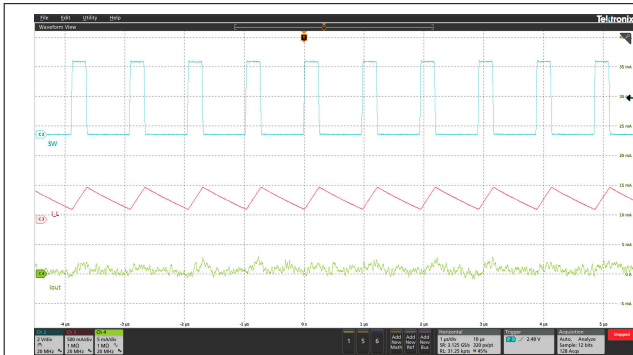
8.2.3.2.3.1 Sense Resistor Selection

The maximum LED current is 1 A , and the corresponding V_{REF} is 99 mV . Using [方程式 1](#), calculate the needed sense resistance at $99 \text{ m}\Omega$. Pay close attention to the power consumption of the sense resistor in this design at 99 mW , and make sure the chosen resistor has enough margin in its power rating.

8.2.3.2.3.1.1 Other External Components Selection

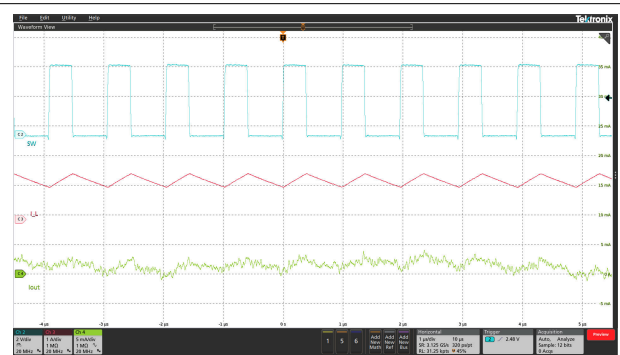
See the [Other External Components Selection](#) section.

8.2.3.3 Application Curves



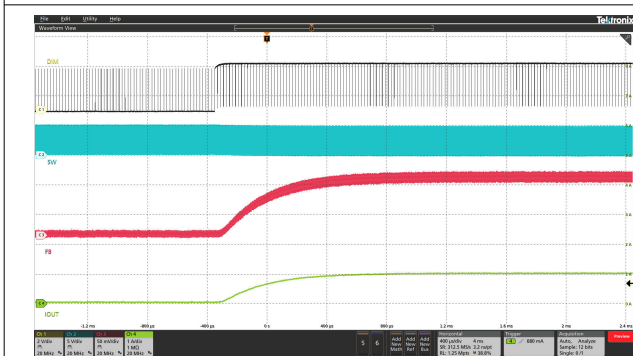
Blue: SW, Red: Inductor Current, Green: LED Current Ripple (AC)

图 8-27. LED Current Ripple at 1% Duty Cycle and 50 kHz



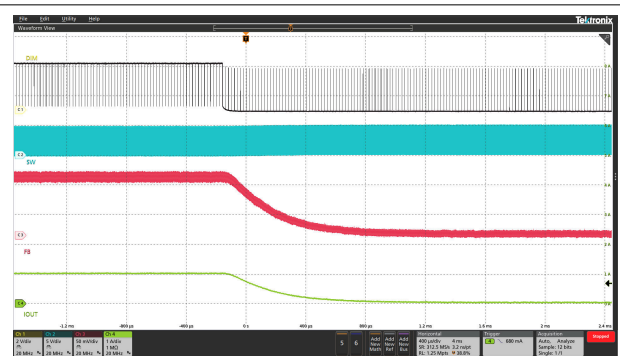
Blue: SW, Red: Inductor Current, Green: LED Current Ripple (AC)

图 8-28. LED Current Ripple at 100% Duty Cycle and 50 kHz



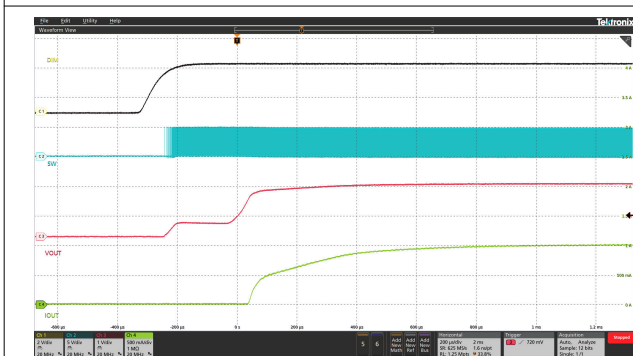
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-29. LED Current Transient From 1% to 100% Duty Cycle at 50 kHz



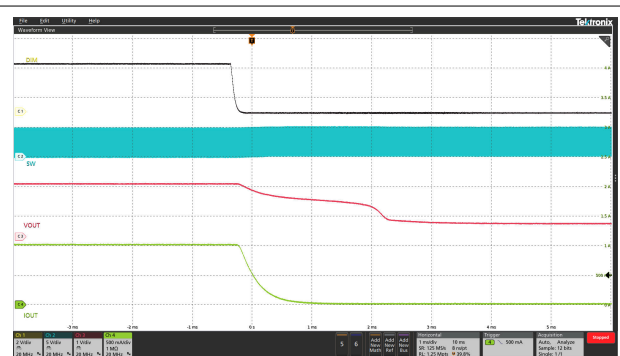
Black: DIM, Blue: SW, Red: FB, Green: LED Current

图 8-30. LED Current Transient From 100% to 1% Duty Cycle at 50 kHz



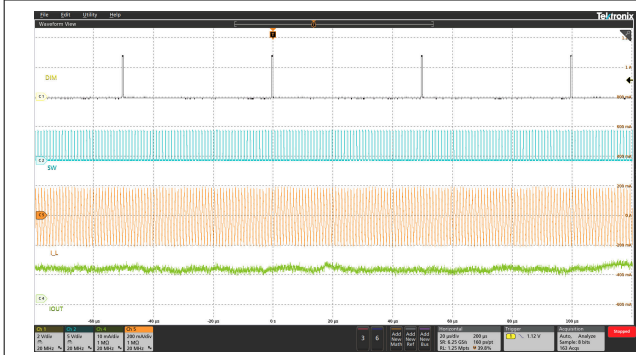
Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

图 8-31. Start-Up at 100% Duty Cycle and 50 kHz



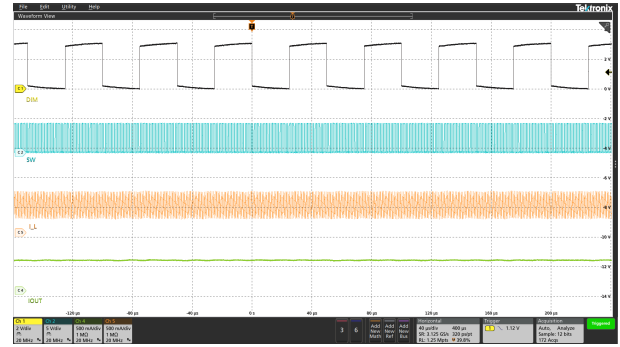
Black: DIM, Blue: SW, Red: VOUT, Green: LED Current

图 8-32. Shutdown at 100% Duty Cycle and 50 kHz



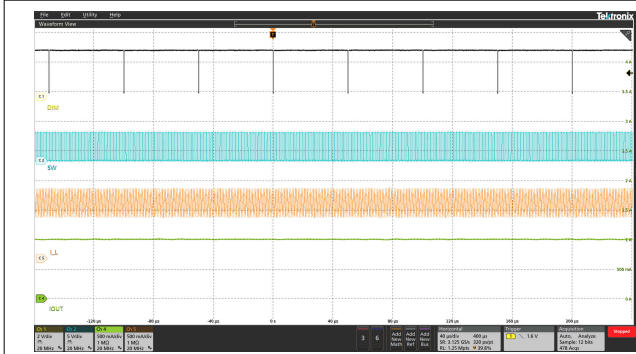
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-33. LED Analog Dimming at 1% Duty Cycle and 20 kHz



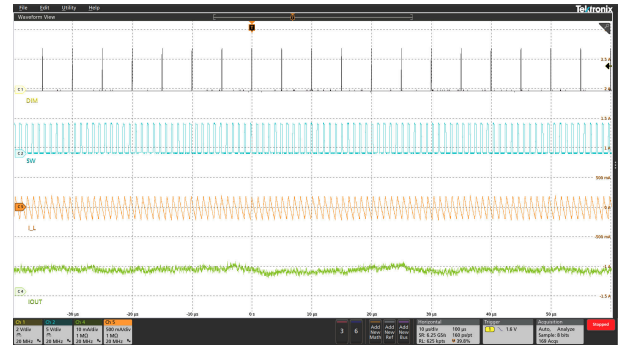
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-34. LED Analog Dimming at 50% Duty Cycle and 20 kHz



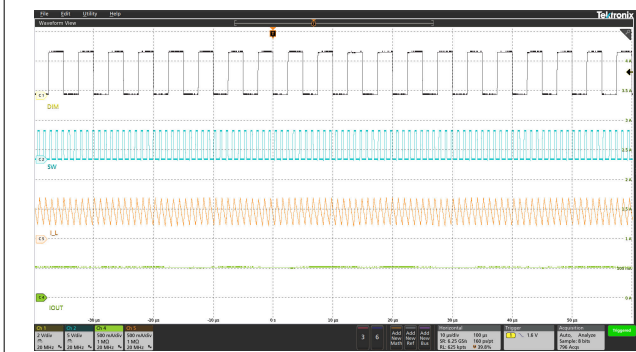
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-35. LED Analog Dimming at 99% Duty Cycle and 20 kHz



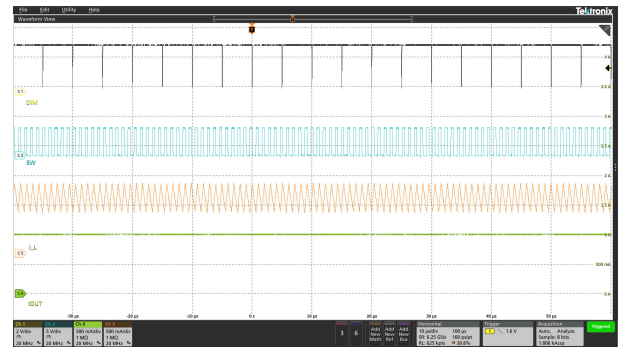
Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-36. LED Analog Dimming at 1% Duty Cycle and 200 kHz



Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-37. LED Analog Dimming at 50% Duty Cycle and 200 kHz



Black: DIM, Blue: SW, Orange: Inductor Current, Green: LED Current

图 8-38. LED Analog Dimming at 99% Duty Cycle and 200 kHz

9 Power Supply Recommendations

The devices are designed to operate from an input voltage supply range between 4 V and 30 V. This input supply must be well regulated. The device requires an input capacitor to reduce the surge current drawn from the input supply and the switching noise from the device. Ceramic capacitors with X5R or X7R dielectrics are highly recommended because of their low ESR and small temperature coefficients. For most applications, a 10- μ F capacitor is enough.

10 Layout

The TPS92200 device requires a proper layout for optimal performance. The following section gives some guidelines to ensure a proper layout.

10.1 Layout Guidelines

An example of a proper layout for the TPS92200 device is shown in [图 10-1](#).

- Creating a large GND plane for good electrical and thermal performance is important.
- The IN and GND traces must be as wide as possible to reduce trace impedance. Wide traces have the additional advantage of providing excellent heat dissipation.
- Thermal vias can be used to connect the top-side GND plane to additional printed-circuit board (PCB) layers for heat dissipation and grounding.
- The input capacitors must be located as close as possible to the IN pin and the GND pin.
- The SW trace must be kept as short as possible to reduce radiated noise and EMI.
- Do not allow switching current to flow under the device.
- The FB trace must be kept as short as possible and placed away from the high-voltage switching trace and the ground shield.
- In higher-current applications, routing the load current of the current-sense resistor to the junction of the input capacitor and GND node can be necessary.

10.2 Layout Example

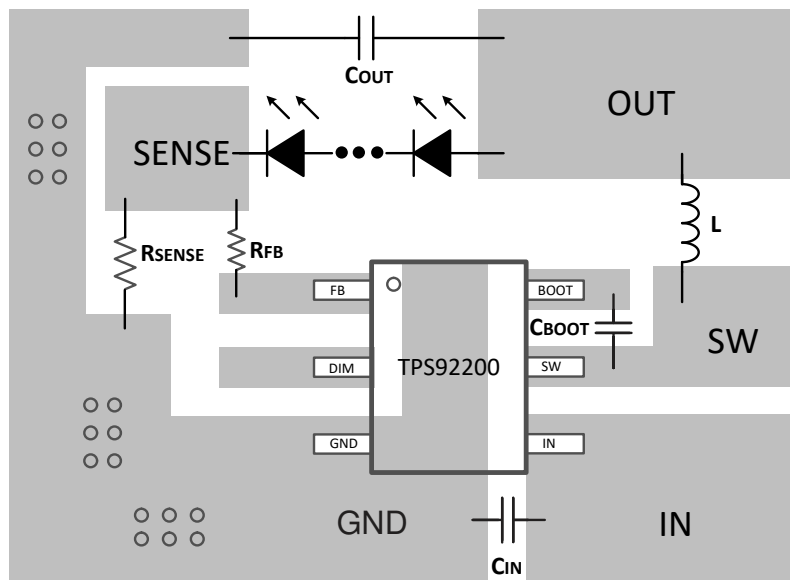


图 10-1. DDC Package Layout Example

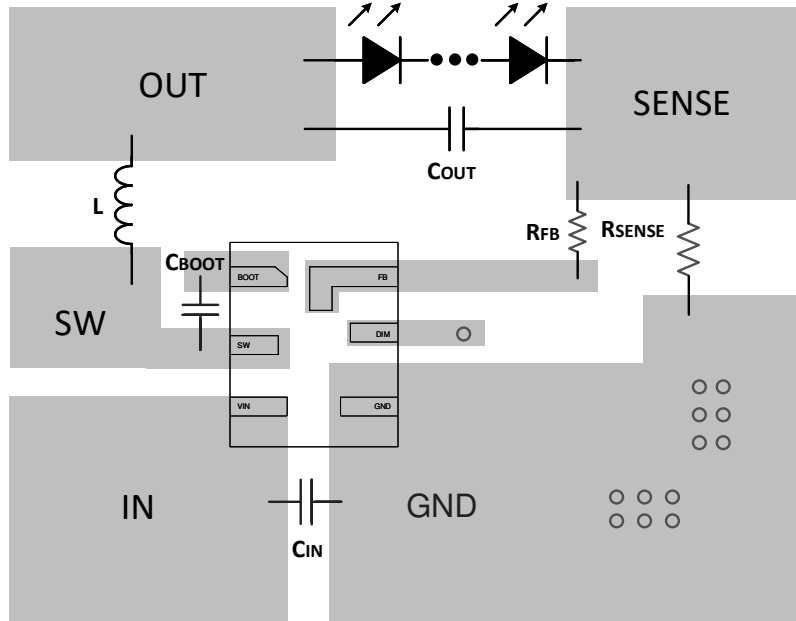


图 10-2. RXL Package Layout Example

11 Device and Documentation Support

11.1 接收文档更新通知

要接收文档更新通知，请导航至 ti.com 上的器件产品文件夹。点击 [订阅更新](#) 进行注册，即可每周接收产品信息更改摘要。有关更改的详细信息，请查看任何已修订文档中包含的修订历史记录。

11.2 支持资源

[TI E2E™ 支持论坛](#) 是工程师的重要参考资料，可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者“按原样”提供。这些内容并不构成 TI 技术规范，并且不一定反映 TI 的观点；请参阅 TI 的《[使用条款](#)》。

11.3 Trademarks

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11.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

11.5 术语表

[TI 术语表](#) 本术语表列出并解释了术语、首字母缩略词和定义。

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most-current data available for the designated devices. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.

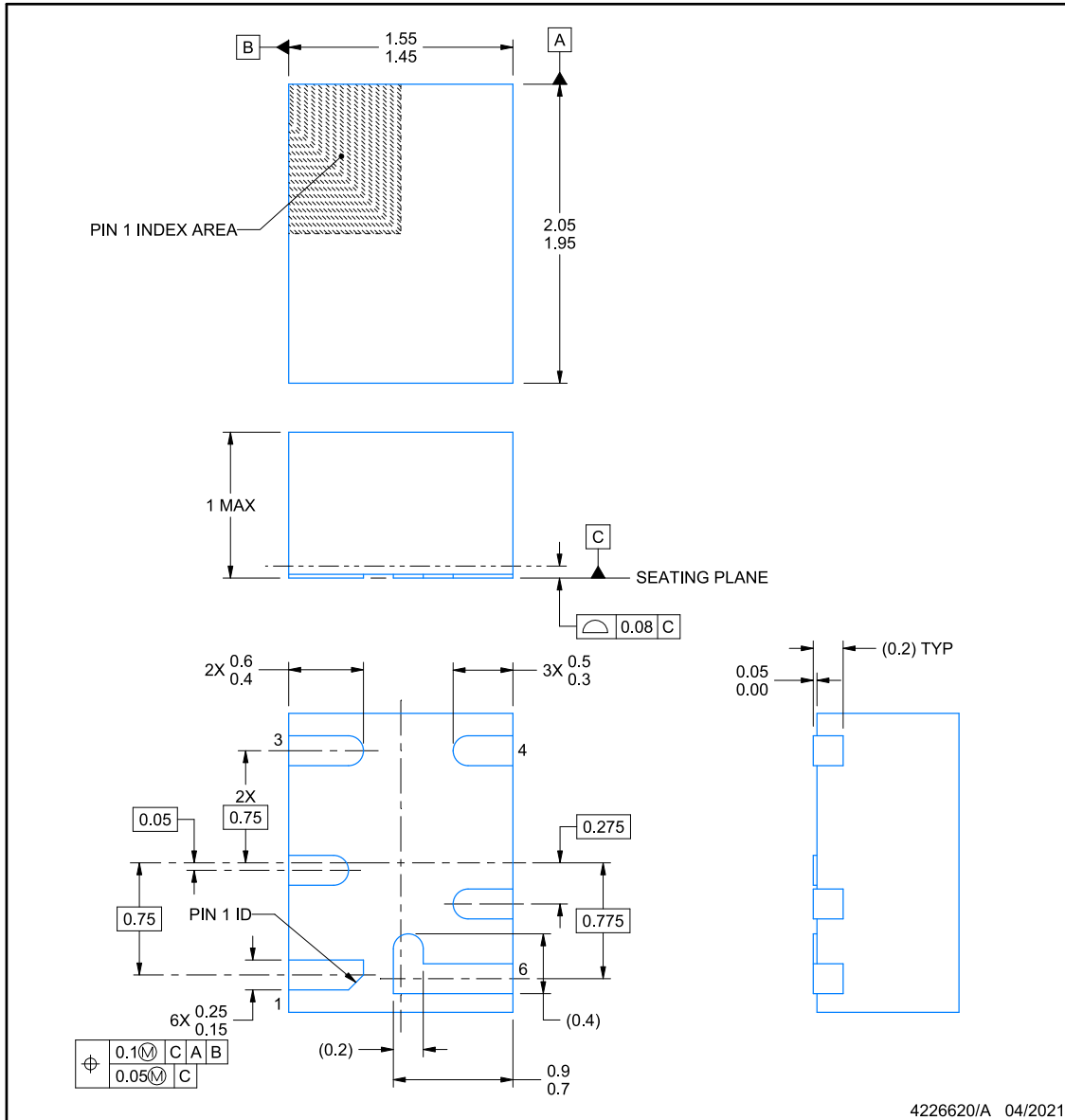


RXL0006A

PACKAGE OUTLINE

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES:

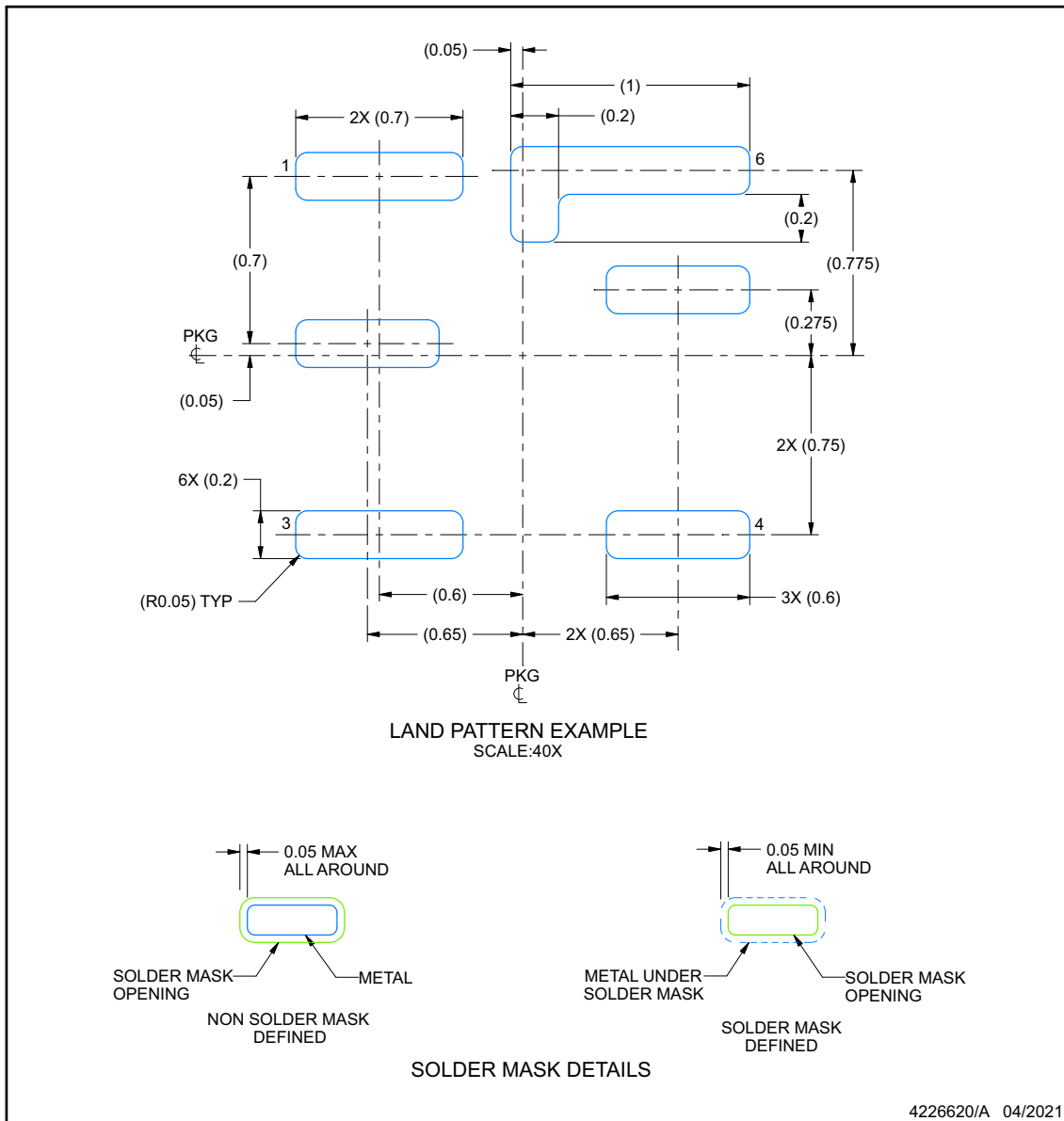
- All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

RXL0006A

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

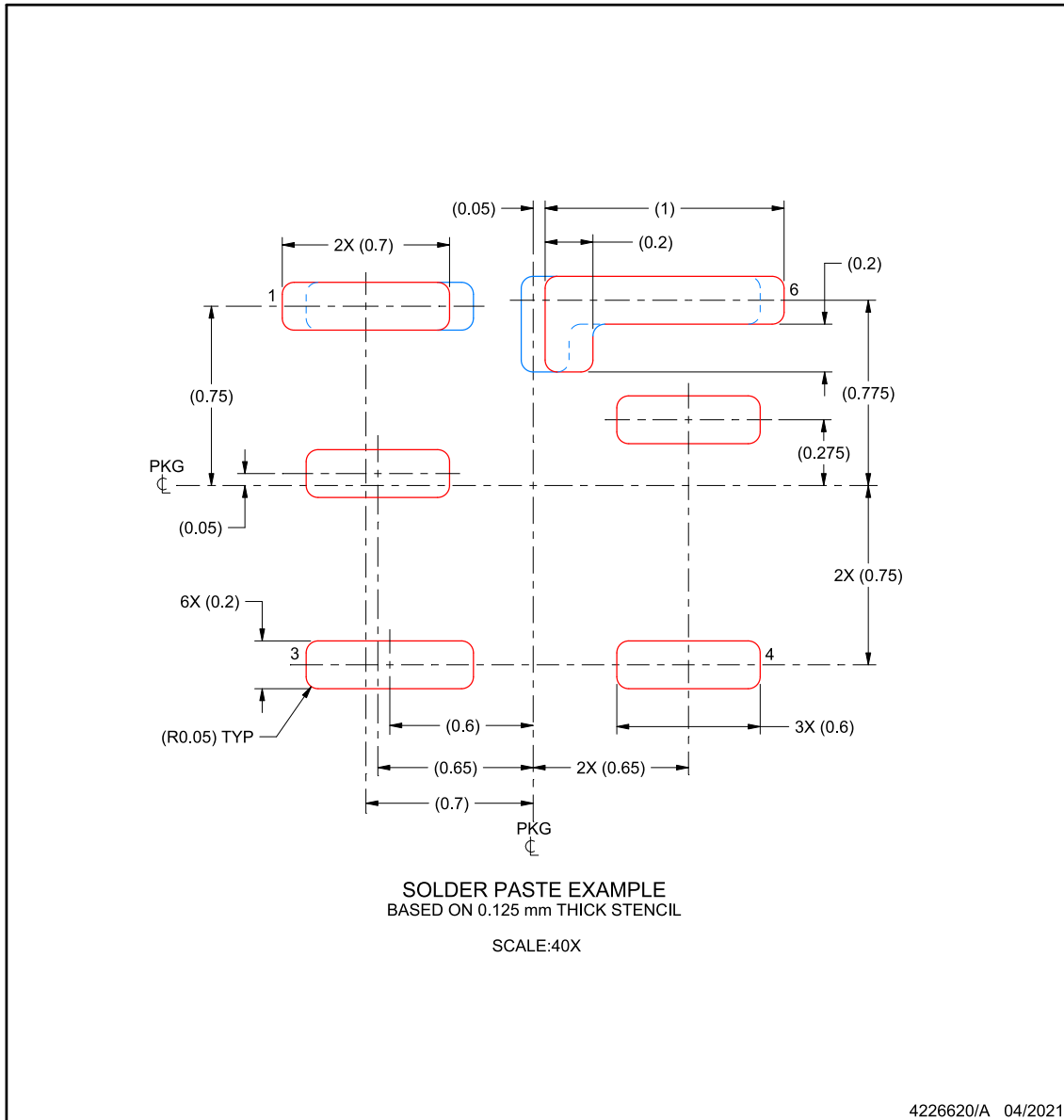
3. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

RXL0006A

VQFN-HR - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TPS92200D1DDCR	Active	Production	SOT-23-THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1SZK
TPS92200D1DDCR.A	Active	Production	SOT-23-THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1SZK
TPS92200D1RXLR	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JQ
TPS92200D1RXLR.A	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JQ
TPS92200D2DDCR	Active	Production	SOT-23-THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1T1K
TPS92200D2DDCR.A	Active	Production	SOT-23-THIN (DDC) 6	3000 LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 85	1T1K
TPS92200D2RXLR	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JP
TPS92200D2RXLR.A	Active	Production	VQFN-HR (RXL) 6	3000 LARGE T&R	Yes	SN	Level-2-260C-1 YEAR	-40 to 85	1JP

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS92200D1DDCR	SOT-23-THIN	DDC	6	3000	180.0	9.5	3.17	3.1	1.1	4.0	8.0	Q3
TPS92200D1DDCR	SOT-23-THIN	DDC	6	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS92200D1RXLR	VQFN-HR	RXL	6	3000	180.0	8.4	1.75	2.25	1.0	4.0	8.0	Q1
TPS92200D2DDCR	SOT-23-THIN	DDC	6	3000	180.0	9.5	3.17	3.1	1.1	4.0	8.0	Q3
TPS92200D2DDCR	SOT-23-THIN	DDC	6	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
TPS92200D2RXLR	VQFN-HR	RXL	6	3000	180.0	8.4	1.75	2.25	1.0	4.0	8.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

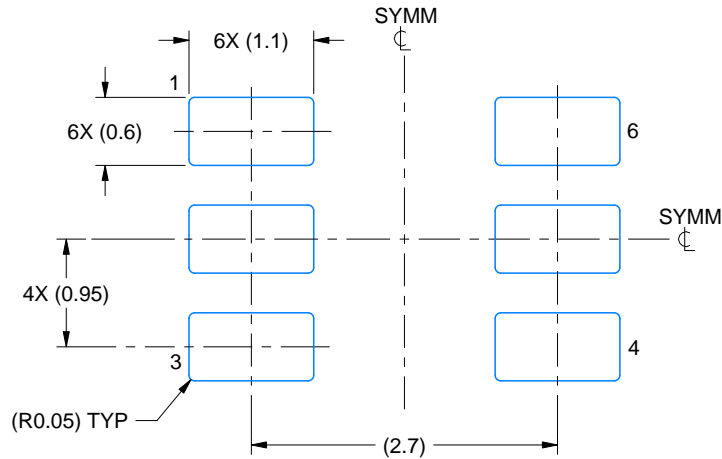
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS92200D1DDCR	SOT-23-THIN	DDC	6	3000	184.0	184.0	19.0
TPS92200D1DDCR	SOT-23-THIN	DDC	6	3000	210.0	185.0	35.0
TPS92200D1RXLR	VQFN-HR	RXL	6	3000	210.0	185.0	35.0
TPS92200D2DDCR	SOT-23-THIN	DDC	6	3000	184.0	184.0	19.0
TPS92200D2DDCR	SOT-23-THIN	DDC	6	3000	210.0	185.0	35.0
TPS92200D2RXLR	VQFN-HR	RXL	6	3000	210.0	185.0	35.0

EXAMPLE BOARD LAYOUT

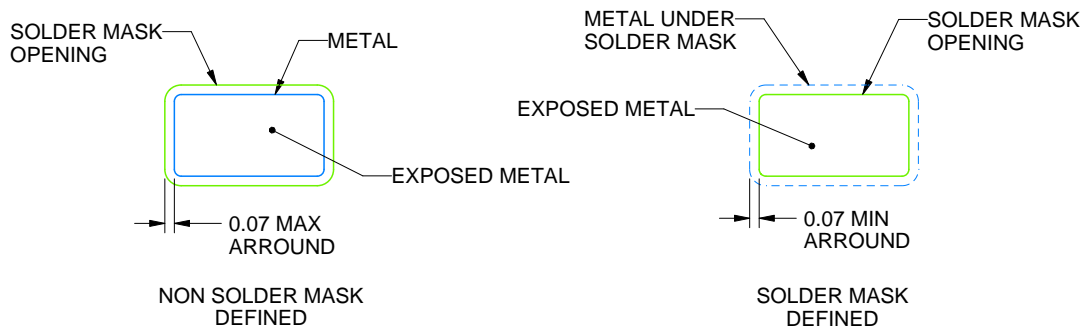
DDC0006A

SOT-23 - 1.1 max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE
EXPLODED METAL SHOWN
SCALE:15X



SOLDEMASK DETAILS

4214841/E 08/2024

NOTES: (continued)

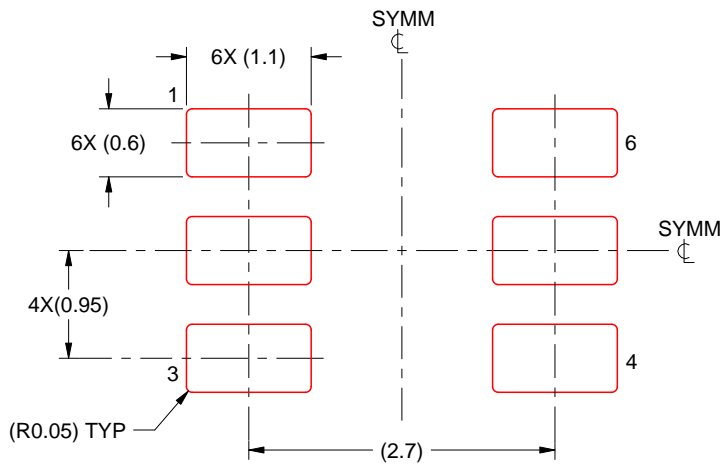
- 4. Publication IPC-7351 may have alternate designs.
- 5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DDC0006A

SOT-23 - 1.1 max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:15X

4214841/E 08/2024

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

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